

# TLV2241, TLV2242, TLV2244 FAMILY OF 1- $\mu$ A/Ch RAIL-TO-RAIL INPUT/OUTPUT OPERATIONAL AMPLIFIERS

SLOS329C – JULY 2000 REVISED - NOVEMBER 2000

- Micropower Operation . . . 1  $\mu$ A/Channel
- Rail-to-Rail Input/Output
- Gain Bandwidth Product . . . 5.5 kHz
- Supply Voltage Range . . . 2.5 V to 12 V
- Specified Temperature Range
  - $T_A = 0^\circ\text{C}$  to  $70^\circ\text{C}$  . . . Commercial Grade
  - $T_A = -40^\circ\text{C}$  to  $125^\circ\text{C}$  . . . Industrial Grade
- Ultrasmall Packaging
  - 5-Pin SOT-23 (TLV2241)
  - 8-Pin MSOP (TLV2242)
- Universal OpAmp EVM

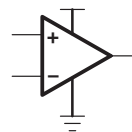
## description

The TLV224x family of single-supply operational amplifiers offers very low supply current of only 1  $\mu$ A per channel.

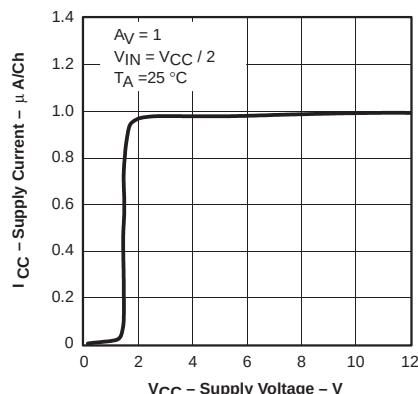
The low supply current is coupled with extremely low input bias currents enabling them to be used with mega- $\Omega$  resistors making them ideal for portable, long active life, applications. DC accuracy is ensured with a low typical offset voltage as low as 600  $\mu$ V, CMRR of 100 dB, and minimum open loop gain of 100 V/mV at 2.7 V.

The maximum recommended supply voltage is as high as 12 V and ensured operation down to 2.5 V, with electrical characteristics specified at 2.7 V, 5 V and 12 V. The 2.5-V operation makes it compatible with Li-Ion battery-powered systems and many micropower microcontrollers available today including TI's MSP430.

Operational Amplifier



SUPPLY CURRENT  
vs  
SUPPLY VOLTAGE



FAMILY PACKAGE TABLE

| DEVICE  | NO. OF Ch | PACKAGE TYPES |      |        |       |      | UNIVERSAL EVM                                   |
|---------|-----------|---------------|------|--------|-------|------|-------------------------------------------------|
|         |           | PDIP          | SOIC | SOT-23 | TSSOP | MSOP |                                                 |
| TLV2241 | 1         | 8             | 8    | 5      | —     | —    | Refer to the EVM Selection Guide (Lit# SLOU060) |
| TLV2242 | 2         | 8             | 8    | —      | —     | 8    |                                                 |
| TLV2244 | 4         | 14            | 14   | —      | 14    | —    |                                                 |

SELECTION OF SINGLE SUPPLY OPERATIONAL AMPLIFIER PRODUCTS<sup>†</sup>

| DEVICE               | V <sub>DD</sub> (V) | V <sub>IO</sub> (mV) | BW (MHz) | SLEW RATE (V/ $\mu$ s) | I <sub>DD</sub> (PER CHANNEL) ( $\mu$ A) | RAIL-TO-RAIL |
|----------------------|---------------------|----------------------|----------|------------------------|------------------------------------------|--------------|
| TLV240x <sup>‡</sup> | 2.5–16              | 0.390                | 0.005    | 0.002                  | 0.880                                    | I/O          |
| TLV224x              | 2.5–12              | 0.600                | 0.005    | 0.002                  | 1                                        | I/O          |
| TLV2211              | 2.7–10              | 0.450                | 0.065    | 0.025                  | 13                                       | O            |
| TLV245x              | 2.7–6               | 0.020                | 0.22     | 0.110                  | 23                                       | I/O          |
| TLV225x              | 2.7–8               | 0.200                | 0.2      | 0.12                   | 35                                       | O            |

<sup>†</sup> All specifications are typical values measured at 5 V.

<sup>‡</sup> This device also offers 18-V reverse battery protection and 5-V over-the-rail operation on the inputs.



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

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# TLV2241, TLV2242, TLV2244

## FAMILY OF 1- $\mu$ A/Ch RAIL-TO-RAIL INPUT/OUTPUT

### OPERATIONAL AMPLIFIERS

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#### TLV2241 AVAILABLE OPTIONS

| $T_A$          | $V_{IOmax}$<br>AT 25°C | PACKAGED DEVICES                  |                              |         |                    |
|----------------|------------------------|-----------------------------------|------------------------------|---------|--------------------|
|                |                        | SMALL OUTLINE <sup>†</sup><br>(D) | SOT-23 <sup>‡</sup><br>(DBV) | SYMBOLS | PLASTIC DIP<br>(P) |
| 0°C to 70°C    | 3000 $\mu$ V           | TLV2241CD                         | —                            | —       | —                  |
| –40°C to 125°C |                        | TLV2241ID                         | TLV2241IDBV                  | VBEI    | TLV2241IP          |

<sup>†</sup> This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLV2241CDR).

<sup>‡</sup> This package is available in a 250 piece mini-reel. To order this package, add a T suffix to the part number (e.g., TLV2241IDBVT). This package is also available in a 3000 piece reel, add a R suffix to the part number (e.g., TLV2241IDBVR).

#### TLV2242 AVAILABLE OPTIONS

| $T_A$          | $V_{IOmax}$<br>AT 25°C | PACKAGED DEVICES                  |                            |         |                    |
|----------------|------------------------|-----------------------------------|----------------------------|---------|--------------------|
|                |                        | SMALL OUTLINE <sup>†</sup><br>(D) | MSOP <sup>†</sup><br>(DGK) | SYMBOLS | PLASTIC DIP<br>(P) |
| 0°C to 70°C    | 3000 $\mu$ V           | TLV2242CD                         | —                          | —       | —                  |
| –40°C to 125°C |                        | TLV2242ID                         | TLV2242IDGK                | xxTIALE | TLV2242IP          |

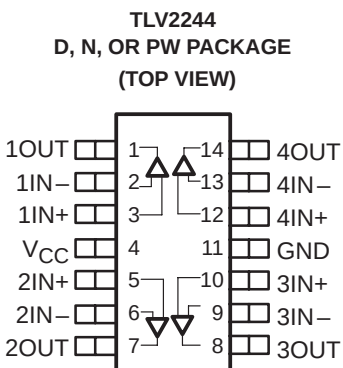
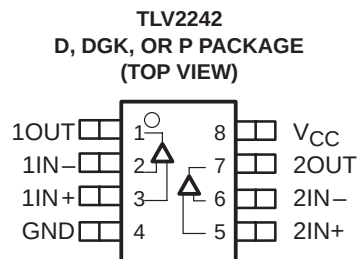
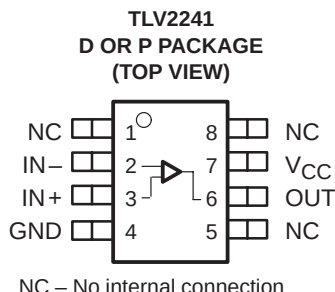
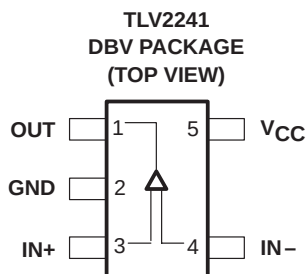
<sup>†</sup> This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLV2242CDR).

#### TLV2244 AVAILABLE OPTIONS

| $T_A$          | $V_{IOmax}$<br>AT 25°C | PACKAGED DEVICES                  |                    |               |
|----------------|------------------------|-----------------------------------|--------------------|---------------|
|                |                        | SMALL OUTLINE <sup>†</sup><br>(D) | PLASTIC DIP<br>(N) | TSSOP<br>(PW) |
| 0°C to 70°C    | 3000 $\mu$ V           | TLV2244CD                         | —                  | —             |
| –40°C to 125°C |                        | TLV2244ID                         | TLV2244IN          | TLV2244IPW    |

<sup>†</sup> This package is available taped and reeled. To order this packaging option, add an R suffix to the part number (e.g., TLV2244CDR).

#### TLV224x PACKAGE PINOUTS



**TLV2241, TLV2242, TLV2244**  
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**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>†</sup>**

|                                                              |                              |
|--------------------------------------------------------------|------------------------------|
| Supply voltage, $V_{CC}$ (see Note 1)                        | 16.5 V                       |
| Differential input voltage, $V_{ID}$                         | $\pm V_{CC}$                 |
| Input current, $I_I$ (any input)                             | $\pm 10$ mA                  |
| Output current, $I_O$                                        | $\pm 10$ mA                  |
| Continuous total power dissipation                           | See Dissipation Rating Table |
| Operating free-air temperature range, $T_A$ : C suffix       | 0°C to 70°C                  |
| I suffix                                                     | –40°C to 125°C               |
| Maximum junction temperature, $T_J$                          | 150°C                        |
| Storage temperature range, $T_{stg}$                         | –65°C to 150°C               |
| Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds | 260°C                        |

<sup>†</sup> Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: All voltage values, except differential voltages, are with respect to GND

**DISSIPATION RATING TABLE**

| PACKAGE | $\theta_{JC}$<br>(°C/W) | $\theta_{JA}$<br>(°C/W) | $T_A \leq 25^\circ\text{C}$<br>POWER RATING | $T_A = 125^\circ\text{C}$<br>POWER RATING |
|---------|-------------------------|-------------------------|---------------------------------------------|-------------------------------------------|
| D (8)   | 38.3                    | 176                     | 710 mW                                      | 142 mW                                    |
| D (14)  | 26.9                    | 122.6                   | 1022 mW                                     | 204.4 mW                                  |
| DBV (5) | 55                      | 324.1                   | 385 mW                                      | 77.1 mW                                   |
| DGK (8) | 54.2                    | 259.9                   | 481 mW                                      | 96.2 mW                                   |
| N (14)  | 32                      | 78                      | 1600 mW                                     | 320.5 mW                                  |
| P (8)   | 41                      | 104                     | 1200 mW                                     | 240.4 mW                                  |
| PW (14) | 29.3                    | 173.6                   | 720 mW                                      | 144 mW                                    |

**recommended operating conditions**

|                                            |               | MIN        | MAX      | UNIT |
|--------------------------------------------|---------------|------------|----------|------|
| Supply voltage, $V_{CC}$                   | Single supply | 2.5        | 12       | V    |
|                                            | Split supply  | $\pm 1.25$ | $\pm 6$  |      |
| Common-mode input voltage range, $V_{ICR}$ |               | 0          | $V_{CC}$ | V    |
| Operating free-air temperature, $T_A$      | C-suffix      | 0          | 70       | °C   |
|                                            | I-suffix      | –40        | 125      |      |

# TLV2241, TLV2242, TLV2244

## FAMILY OF 1- $\mu$ A/Ch RAIL-TO-RAIL INPUT/OUTPUT

### OPERATIONAL AMPLIFIERS

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electrical characteristics at recommended operating conditions,  $V_{CC} = 2.7, 5 \text{ V}$ , and  $12 \text{ V}$  (unless otherwise noted)<sup>†</sup>

#### dc performance

| PARAMETER                                                | TEST CONDITIONS                                                                    | $T_A^{\dagger}$                                                                   | MIN | TYP | MAX  | UNIT                         |
|----------------------------------------------------------|------------------------------------------------------------------------------------|-----------------------------------------------------------------------------------|-----|-----|------|------------------------------|
| $V_{IO}$ Input offset voltage                            | $V_O = V_{CC}/2 \text{ V}$ ,<br>$V_{IC} = V_{CC}/2 \text{ V}$ , $R_S = 50 \Omega$  | 25°C                                                                              |     | 600 | 3000 | $\mu\text{V}$                |
|                                                          |                                                                                    | Full range                                                                        |     |     | 4500 |                              |
| $\alpha V_{IO}$ Offset voltage drift                     |                                                                                    | 25°C                                                                              |     | 3   |      | $\mu\text{V}/^\circ\text{C}$ |
| CMRR Common-mode rejection ratio                         | $V_{IC} = 0 \text{ to } V_{CC}$ , $R_S = 50 \Omega$                                | $V_{CC} = 2.7 \text{ V}$                                                          |     |     |      | dB                           |
|                                                          |                                                                                    | 25°C                                                                              |     | 55  | 100  |                              |
|                                                          |                                                                                    | Full range                                                                        |     | 50  |      |                              |
|                                                          |                                                                                    | $V_{CC} = 5 \text{ V}$                                                            |     |     |      |                              |
|                                                          |                                                                                    | 25°C                                                                              |     | 60  | 100  |                              |
|                                                          |                                                                                    | Full range                                                                        |     | 53  |      |                              |
|                                                          |                                                                                    | $V_{CC} = 12 \text{ V}$                                                           |     |     |      |                              |
|                                                          |                                                                                    | 25°C                                                                              |     | 60  | 100  |                              |
|                                                          |                                                                                    | Full range                                                                        |     | 55  |      |                              |
| $A_{VD}$ Large-signal differential voltage amplification | $V_{CC} = 2.7 \text{ V}$ , $V_{O(pp)} = 1 \text{ V}$ , $R_L = 500 \text{ k}\Omega$ | 25°C                                                                              |     | 100 | 400  | V/mV                         |
|                                                          |                                                                                    | Full range                                                                        |     | 30  |      |                              |
|                                                          |                                                                                    | $V_{CC} = 5 \text{ V}$ , $V_{O(pp)} = 3 \text{ V}$ , $R_L = 500 \text{ k}\Omega$  |     |     |      |                              |
|                                                          |                                                                                    | 25°C                                                                              |     | 250 | 1000 |                              |
|                                                          |                                                                                    | Full range                                                                        |     | 100 |      |                              |
|                                                          |                                                                                    | $V_{CC} = 12 \text{ V}$ , $V_{O(pp)} = 6 \text{ V}$ , $R_L = 500 \text{ k}\Omega$ |     |     |      |                              |
|                                                          |                                                                                    | 25°C                                                                              |     | 700 | 1500 |                              |
|                                                          |                                                                                    | Full range                                                                        |     | 120 |      |                              |

<sup>†</sup> Full range is 0°C to 70°C for the C suffix and –40°C to 125°C for the I suffix. If not specified, full range is –40°C to 125°C.

#### input characteristics

| PARAMETER                                | TEST CONDITIONS                                                                   | $T_A^{\dagger}$ | MIN | TYP | MAX  | UNIT             |
|------------------------------------------|-----------------------------------------------------------------------------------|-----------------|-----|-----|------|------------------|
| $I_{IO}$ Input offset current            | $V_O = V_{CC}/2 \text{ V}$ ,<br>$V_{IC} = V_{CC}/2 \text{ V}$ , $R_S = 50 \Omega$ | 25°C            |     | 25  | 250  | pA               |
|                                          |                                                                                   | TLV224xC        |     |     | 300  |                  |
|                                          |                                                                                   | TLV224xI        |     |     | 400  |                  |
| $I_{IB}$ Input bias current              | $V_O = V_{CC}/2 \text{ V}$ ,<br>$V_{IC} = V_{CC}/2 \text{ V}$ , $R_S = 50 \Omega$ | 25°C            |     | 100 | 500  | pA               |
|                                          |                                                                                   | TLV224xC        |     |     | 550  |                  |
|                                          |                                                                                   | TLV224xI        |     |     | 1000 |                  |
| $r_{i(d)}$ Differential input resistance |                                                                                   | 25°C            |     | 300 |      | $\text{M}\Omega$ |
| $C_{i(c)}$ Common-mode input capacitance | $f = 100 \text{ kHz}$                                                             | 25°C            |     | 3   |      | pF               |

<sup>†</sup> Full range is 0°C to 70°C for the C suffix and –40°C to 125°C for the I suffix. If not specified, full range is –40°C to 125°C.

<sup>‡</sup> Specifications at 5 V are ensured by design and device testing at 2.7 V and 12 V.



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electrical characteristics at recommended operating conditions,  $V_{CC} = 2.7, 5 \text{ V}$ , and  $12 \text{ V}$  (unless otherwise noted)<sup>†</sup> (continued)

**output characteristics**

| PARAMETER       |                           | TEST CONDITIONS                                                   |                         | T <sub>A</sub> <sup>†</sup> | MIN   | TYP   | MAX | UNIT |
|-----------------|---------------------------|-------------------------------------------------------------------|-------------------------|-----------------------------|-------|-------|-----|------|
| V <sub>OH</sub> | High-level output voltage | V <sub>IC</sub> = V <sub>CC</sub> /2,<br>I <sub>OH</sub> = −2 μA  | V <sub>CC</sub> = 2.7 V | 25°C                        | 2.65  | 2.68  |     | V    |
|                 |                           |                                                                   |                         | Full range                  | 2.63  |       |     |      |
|                 |                           |                                                                   | V <sub>CC</sub> = 5 V   | 25°C                        | 4.95  | 4.98  |     |      |
|                 |                           |                                                                   |                         | Full range                  | 4.93  |       |     |      |
|                 |                           |                                                                   | V <sub>CC</sub> = 12 V  | 25°C                        | 11.95 | 11.98 |     |      |
|                 |                           |                                                                   |                         | Full range                  | 11.93 |       |     |      |
|                 |                           | V <sub>IC</sub> = V <sub>CC</sub> /2,<br>I <sub>OH</sub> = −50 μA | V <sub>CC</sub> = 2.7 V | 25°C                        | 2.62  | 2.65  |     |      |
|                 |                           |                                                                   |                         | Full range                  | 2.6   |       |     |      |
|                 |                           |                                                                   | V <sub>CC</sub> = 5 V   | 25°C                        | 4.92  | 4.95  |     |      |
|                 |                           |                                                                   |                         | Full range                  | 4.9   |       |     |      |
|                 |                           |                                                                   | V <sub>CC</sub> = 12 V  | 25°C                        | 11.92 | 11.95 |     |      |
|                 |                           |                                                                   |                         | Full range                  | 11.9  |       |     |      |
| V <sub>OL</sub> | Low-level output voltage  | V <sub>IC</sub> = V <sub>CC</sub> /2, I <sub>OL</sub> = 2 μA      |                         | 25°C                        |       | 90    | 150 | mV   |
|                 |                           |                                                                   |                         | Full range                  |       |       | 180 |      |
|                 |                           | V <sub>IC</sub> = V <sub>CC</sub> /2, I <sub>OL</sub> = 50 μA     |                         | 25°C                        |       | 180   | 230 |      |
|                 |                           |                                                                   |                         | Full range                  |       |       | 260 |      |
| I <sub>O</sub>  | Output current            | V <sub>O</sub> = 0.5 V from rail                                  |                         | 25°C                        |       | ±200  |     | μA   |

<sup>†</sup> Full range is 0°C to 70°C for the C suffix and –40°C to 125°C for the I suffix. If not specified, full range is –40°C to 125°C.

**power supply**

| PARAMETER                                                              | TEST CONDITIONS                                                                  |                                           | $T_A^{\dagger}$ | MIN | TYP  | MAX  | UNIT |
|------------------------------------------------------------------------|----------------------------------------------------------------------------------|-------------------------------------------|-----------------|-----|------|------|------|
| $I_{CC}$ Supply current (per channel)                                  | $V_O = V_{CC}/2$                                                                 | $V_{CC} = 2.7 \text{ V}$ or $5 \text{ V}$ | 25°C            |     | 980  | 1200 | nA   |
|                                                                        |                                                                                  |                                           | Full range      |     |      | 1500 |      |
|                                                                        |                                                                                  | $V_{CC} = 12 \text{ V}$                   | 25°C            |     | 1000 | 1250 |      |
|                                                                        |                                                                                  |                                           | Full range      |     |      | 1550 |      |
| PSRR Power supply rejection ratio<br>( $\Delta V_{CC}/\Delta V_{IO}$ ) | $V_{CC} = 2.7$ to $5 \text{ V}$ ,<br>$V_{IC} = V_{CC}/2 \text{ V}$ ,<br>No load, | TLV224xC                                  | 25°C            | 70  | 100  |      | dB   |
|                                                                        |                                                                                  |                                           | Full range      | 65  |      |      | dB   |
|                                                                        |                                                                                  | TLV224xI                                  | 25°C            | 70  | 100  |      | dB   |
|                                                                        |                                                                                  |                                           | Full range      | 70  |      |      | dB   |
|                                                                        | $V_{CC} = 5$ to $12 \text{ V}$ , $V_{IC} = V_{CC}/2 \text{ V}$ ,<br>No load      |                                           | 25°C            | 70  | 100  |      | dB   |
|                                                                        |                                                                                  |                                           | Full range      | 70  |      |      | dB   |

<sup>†</sup> Full range is 0°C to 70°C for the C suffix and –40°C to 125°C for the I suffix. If not specified, full range is –40°C to 125°C.

<sup>‡</sup> Specifications at 5 V are ensured by design and device testing at 2.7 V and 12 V.

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**electrical characteristics at recommended operating conditions,  $V_{CC} = 2.7, 5 \text{ V}$ , and  $12 \text{ V}$  (unless otherwise noted)<sup>‡</sup> (continued)**

**dynamic performance**

| PARAMETER |                         | TEST CONDITIONS                                                                                                                                 |                        | $T_A$              | MIN | TYP  | MAX | UNIT |
|-----------|-------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------|------------------------|--------------------|-----|------|-----|------|
| UGBW      | Unity gain bandwidth    | $R_L = 500 \text{ k}\Omega$ ,                                                                                                                   | $C_L = 100 \text{ pF}$ | $25^\circ\text{C}$ |     | 5.5  |     | kHz  |
| SR        | Slew rate at unity gain | $V_{O(pp)} = 0.8 \text{ V}$ , $R_L = 500 \text{ k}\Omega$ ,                                                                                     | $C_L = 100 \text{ pF}$ | $25^\circ\text{C}$ |     | 2    |     | V/ms |
| $\phi M$  | Phase margin            | $R_L = 500 \text{ k}\Omega$ , $C_L = 100 \text{ pF}$                                                                                            |                        | $25^\circ\text{C}$ |     | 60   |     |      |
|           | Gain margin             |                                                                                                                                                 |                        |                    |     | 15   |     | dB   |
| $t_s$     | Settling time           | $V_{CC} = 2.7 \text{ or } 5 \text{ V}$ ,<br>$V_{(STEP)PP} = 1 \text{ V}$ , $C_L = 100 \text{ pF}$ ,<br>$A_V = -1$ , $R_L = 100 \text{ k}\Omega$ | 0.1%                   | $25^\circ\text{C}$ |     | 1.84 |     | ms   |
|           |                         | $V_{CC} = 12 \text{ V}$ ,<br>$V_{(STEP)PP} = 1 \text{ V}$ , $C_L = 100 \text{ pF}$ ,<br>$A_V = -1$ , $R_L = 100 \text{ k}\Omega$                | 0.1%                   |                    |     | 6.1  |     |      |
|           |                         |                                                                                                                                                 | 0.01%                  |                    |     | 32   |     |      |

**noise/distortion performance**

| PARAMETER |                                | TEST CONDITIONS      | $T_A$              | MIN | TYP | MAX | UNIT                         |
|-----------|--------------------------------|----------------------|--------------------|-----|-----|-----|------------------------------|
| $V_n$     | Equivalent input noise voltage | $f = 10 \text{ Hz}$  | $25^\circ\text{C}$ |     | 800 |     | $\text{nV}/\sqrt{\text{Hz}}$ |
|           |                                | $f = 100 \text{ Hz}$ |                    |     | 500 |     |                              |
| $I_n$     | Equivalent input noise current | $f = 100 \text{ Hz}$ |                    |     | 8   |     | $\text{fA}/\sqrt{\text{Hz}}$ |

<sup>‡</sup> Specifications at 5 V are ensured by design and device testing at 2.7 V and 12 V.

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**TYPICAL CHARACTERISTICS**

**Table of Graphs**

|             |                                       |                              | <b>FIGURE</b> |
|-------------|---------------------------------------|------------------------------|---------------|
| $V_{IO}$    | Input offset voltage                  | vs Common-mode input voltage | 1, 2, 3       |
| $I_{IB}$    | Input bias current                    | vs Free-air temperature      | 4, 6, 8       |
|             |                                       | vs Common-mode input voltage | 5, 7, 9       |
| $I_{IO}$    | Input offset current                  | vs Free-air temperature      | 4, 6, 8       |
|             |                                       | vs Common-mode input voltage | 5, 7, 9       |
| CMRR        | Common-mode rejection ratio           | vs Frequency                 | 10            |
| $V_{OH}$    | High-level output voltage             | vs High-level output current | 11, 13, 15    |
| $V_{OL}$    | Low-level output voltage              | vs Low-level output current  | 12, 14, 16    |
| $V_{O(PP)}$ | Output voltage peak-to-peak           | vs Frequency                 | 17            |
| $Z_o$       | Output impedance                      | vs Frequency                 | 18            |
| $I_{CC}$    | Supply current                        | vs Supply voltage            | 19            |
| PSRR        | Power supply rejection ratio          | vs Frequency                 | 20            |
| $A_{VD}$    | Differential voltage gain             | vs Frequency                 | 21            |
|             | Phase                                 | vs Frequency                 | 21            |
|             | Gain-bandwidth product                | vs Supply voltage            | 22            |
| SR          | Slew rate                             | vs Free-air temperature      | 23            |
| $\phi_m$    | Phase margin                          | vs Capacitive load           | 24            |
|             | Gain margin                           | vs Capacitive load           | 25            |
|             | Voltage noise over a 10 Second Period |                              | 26            |
|             | Large-signal voltage follower         |                              | 27, 28, 29    |
|             | Small-signal voltage follower         |                              | 30            |
|             | Large-signal inverting pulse response |                              | 31, 32, 33    |
|             | Small-signal inverting pulse response |                              | 34            |
|             | Crosstalk                             | vs Frequency                 | 35            |



# TLV2241, TLV2242, TLV2244

## FAMILY OF 1- $\mu$ A/ch RAIL-TO-RAIL INPUT/OUTPUT

### OPERATIONAL AMPLIFIERS

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#### TYPICAL CHARACTERISTICS

INPUT OFFSET VOLTAGE  
vs  
COMMON-MODE INPUT  
VOLTAGE

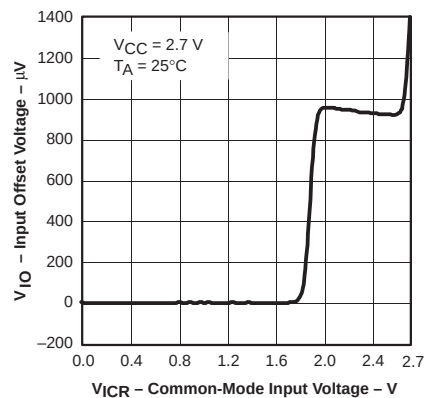


Figure 1

INPUT OFFSET VOLTAGE  
vs  
COMMON-MODE INPUT  
VOLTAGE

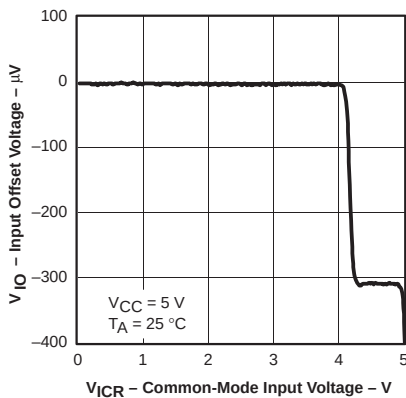


Figure 2

INPUT OFFSET VOLTAGE  
vs  
COMMON-MODE INPUT  
VOLTAGE

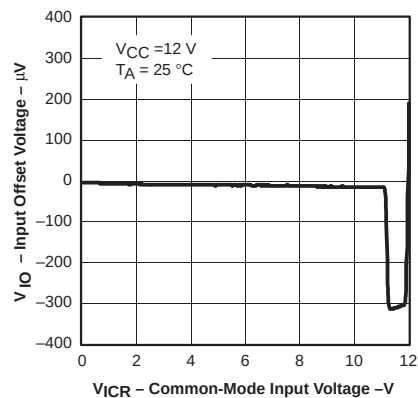


Figure 3

INPUT BIAS / OFFSET CURRENT  
vs  
FREE-AIR TEMPERATURE

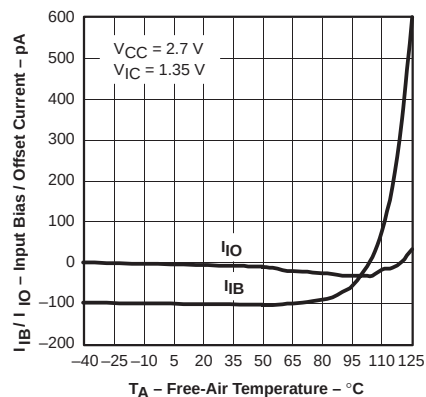


Figure 4

INPUT BIAS / OFFSET CURRENT  
vs  
COMMON MODE INPUT  
VOLTAGE

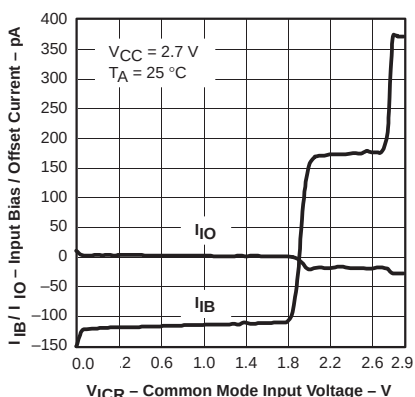


Figure 5

INPUT BIAS / OFFSET CURRENT  
vs  
FREE-AIR TEMPERATURE

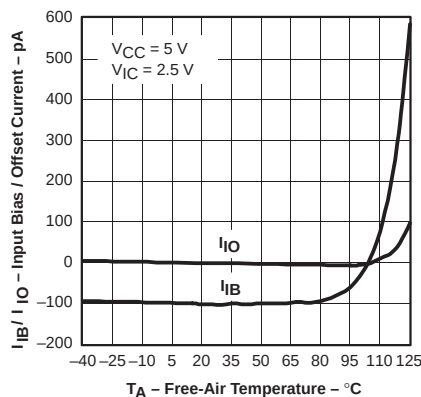


Figure 6

INPUT BIAS / OFFSET CURRENT  
vs  
COMMON-MODE INPUT  
VOLTAGE

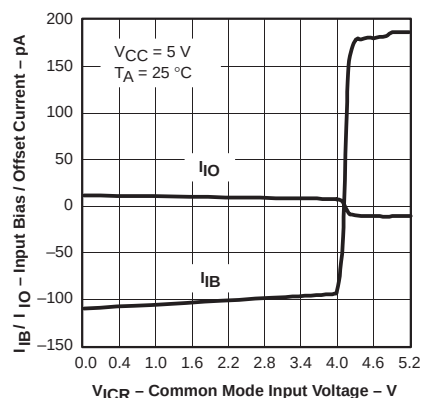


Figure 7

INPUT BIAS / OFFSET CURRENT  
vs  
FREE-AIR TEMPERATURE

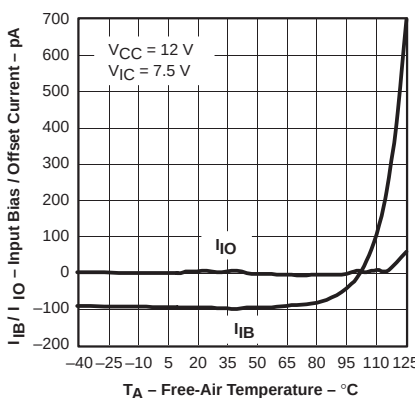


Figure 8

INPUT BIAS / OFFSET CURRENT  
vs  
COMMON-MODE INPUT  
VOLTAGE

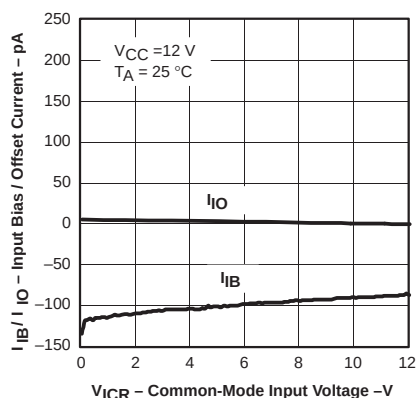


Figure 9



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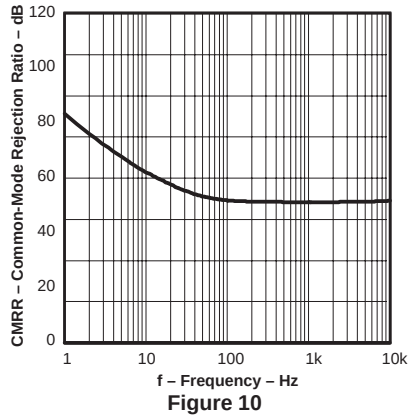
# TLV2241, TLV2242, TLV2244

## FAMILY OF 1- $\mu$ A/Ch RAIL-TO-RAIL INPUT/OUTPUT OPERATIONAL AMPLIFIERS

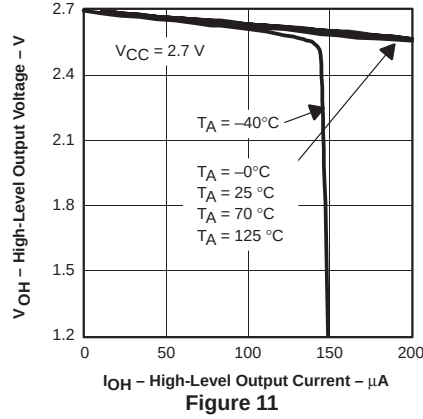
SLOS329C – JULY 2000 REVISED - NOVEMBER 2000

### TYPICAL CHARACTERISTICS

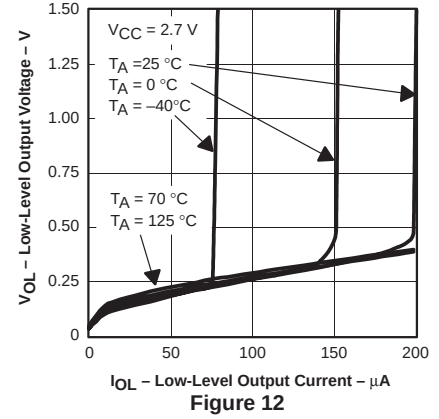
**COMMON-MODE REJECTION RATIO  
VS  
FREQUENCY**



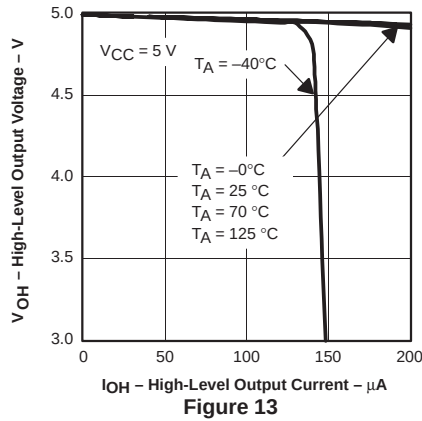
**HIGH-LEVEL OUTPUT VOLTAGE  
VS  
HIGH-LEVEL OUTPUT CURRENT**



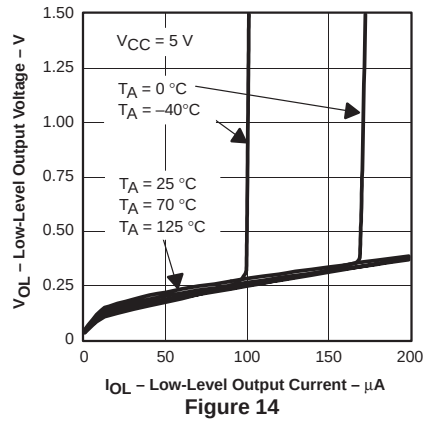
**LOW-LEVEL OUTPUT VOLTAGE  
VS  
LOW-LEVEL OUTPUT CURRENT**



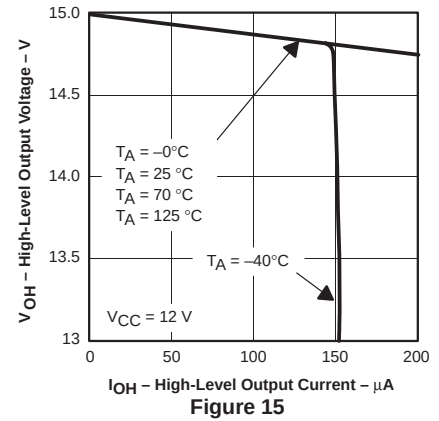
**HIGH-LEVEL OUTPUT VOLTAGE  
VS  
HIGH-LEVEL OUTPUT CURRENT**



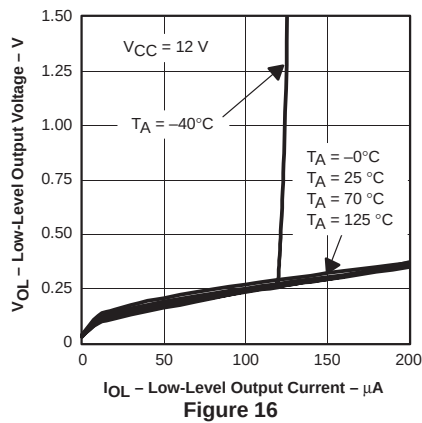
**LOW-LEVEL OUTPUT VOLTAGE  
VS  
LOW-LEVEL OUTPUT CURRENT**



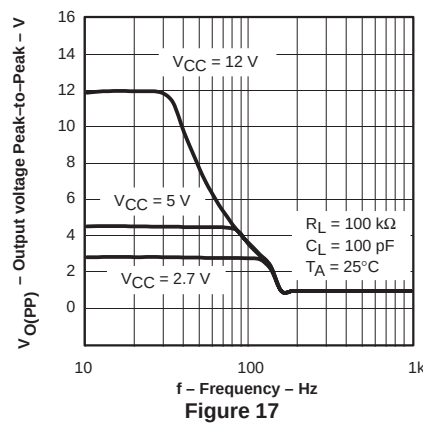
**HIGH-LEVEL OUTPUT VOLTAGE  
VS  
HIGH-LEVEL OUTPUT CURRENT**



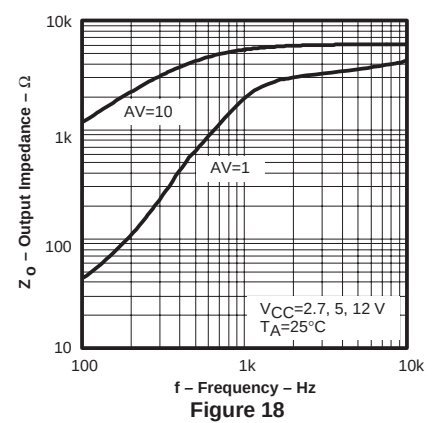
**LOW-LEVEL OUTPUT VOLTAGE  
VS  
LOW-LEVEL OUTPUT CURRENT**



**OUTPUT VOLTAGE  
PEAK-TO-PEAK  
VS  
FREQUENCY**



**OUTPUT IMPEDANCE  
VS  
FREQUENCY**

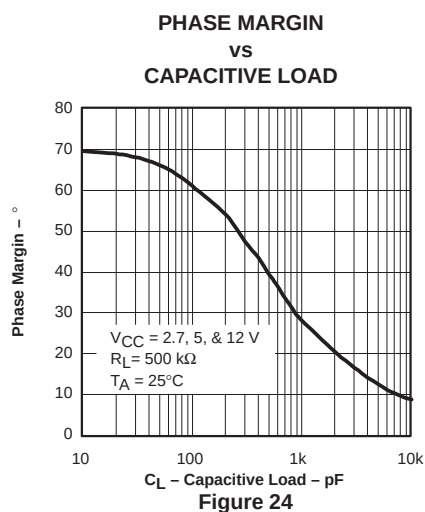
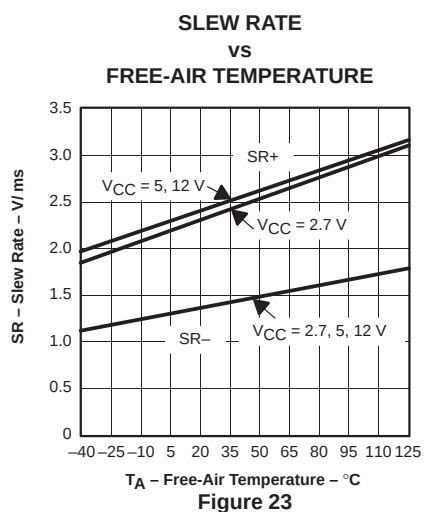
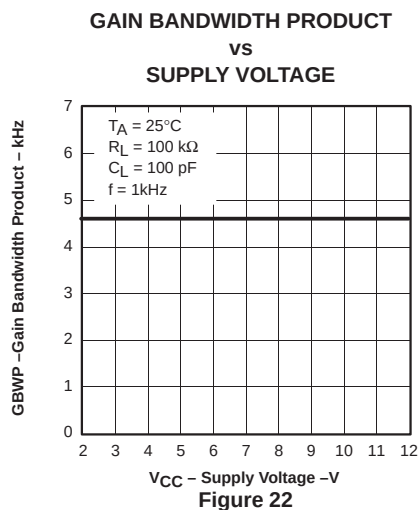
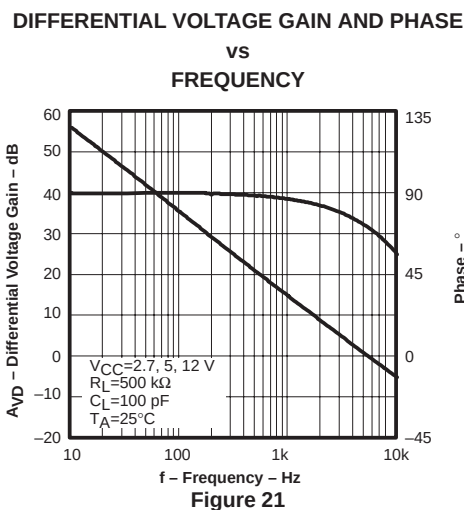
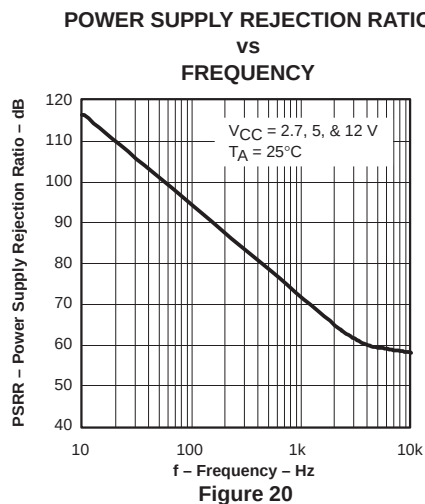
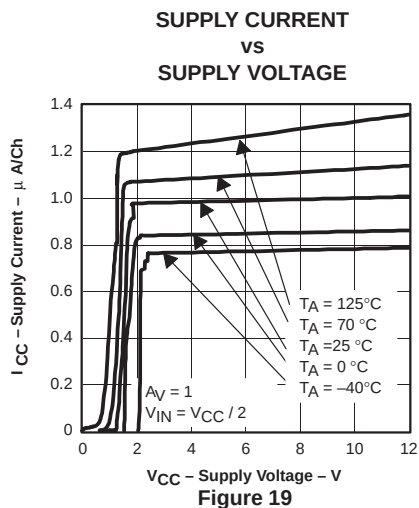


# TLV2241, TLV2242, TLV2244

## FAMILY OF 1- $\mu$ A/ch RAIL-TO-RAIL INPUT/OUTPUT OPERATIONAL AMPLIFIERS

SLOS329C – JULY 2000 REVISED – NOVEMBER 2000

### TYPICAL CHARACTERISTICS



# TLV2241, TLV2242, TLV2244

## FAMILY OF 1- $\mu$ A/Ch RAIL-TO-RAIL INPUT/OUTPUT OPERATIONAL AMPLIFIERS

SLOS329C – JULY 2000 REVISED – NOVEMBER 2000

### TYPICAL CHARACTERISTICS

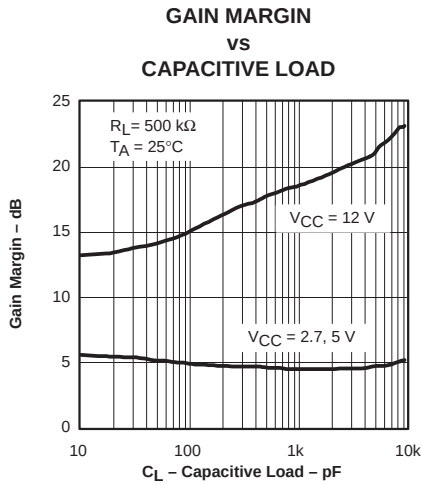


Figure 25

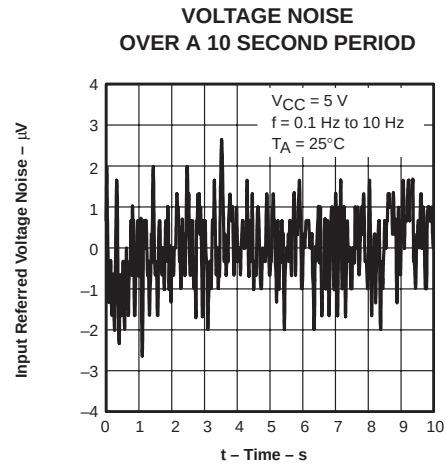


Figure 26

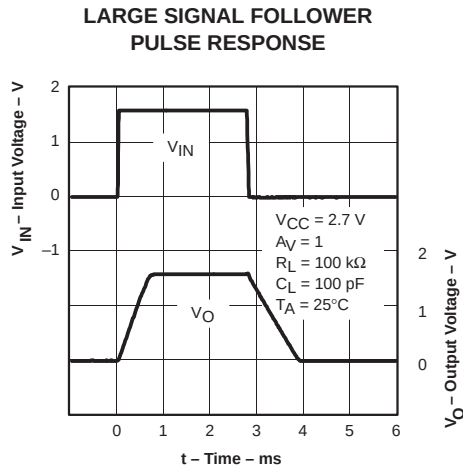


Figure 27

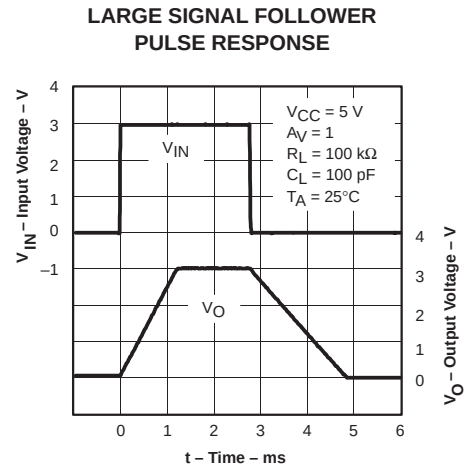


Figure 28

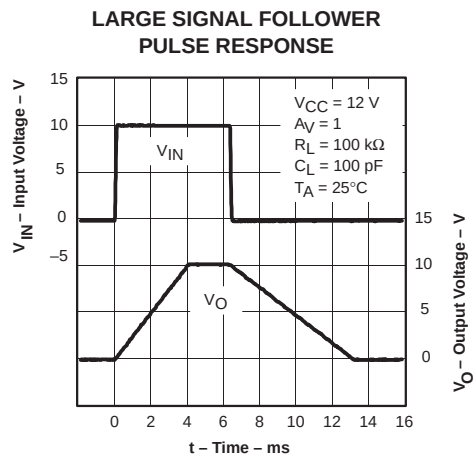


Figure 29

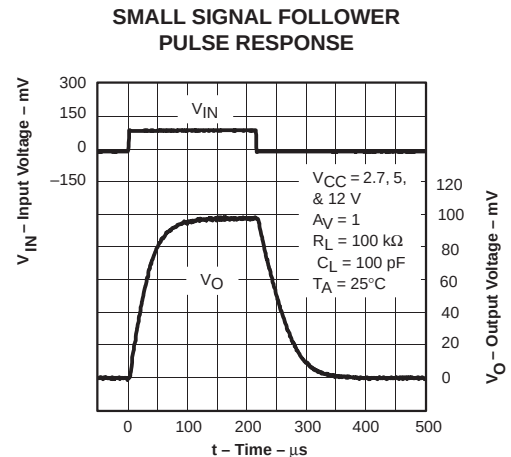


Figure 30

# TLV2241, TLV2242, TLV2244

## FAMILY OF 1- $\mu$ A/Ch RAIL-TO-RAIL INPUT/OUTPUT

### OPERATIONAL AMPLIFIERS

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#### TYPICAL CHARACTERISTICS

**LARGE SIGNAL INVERTING PULSE RESPONSE**

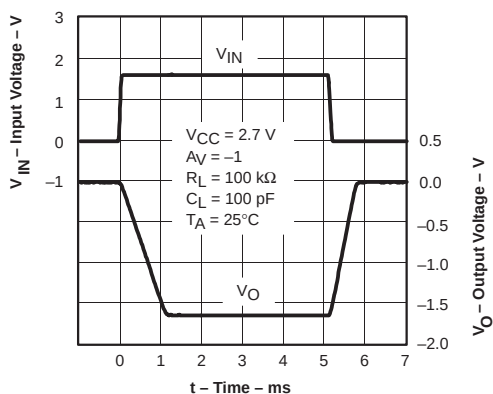


Figure 31

**LARGE SIGNAL INVERTING PULSE RESPONSE**

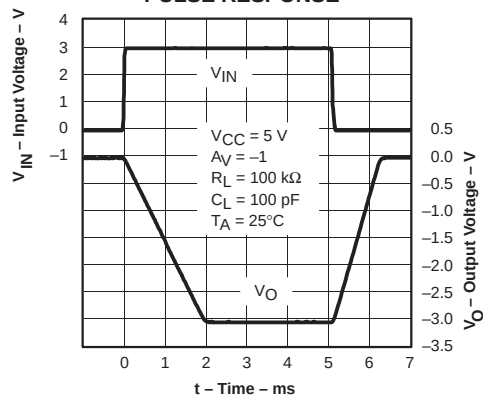


Figure 32

**LARGE SIGNAL INVERTING PULSE RESPONSE**

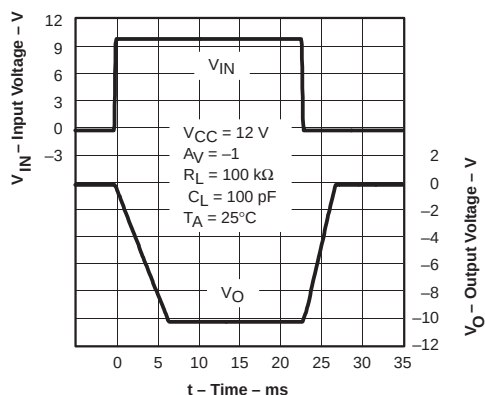


Figure 33

**SMALL SIGNAL INVERTING PULSE RESPONSE**

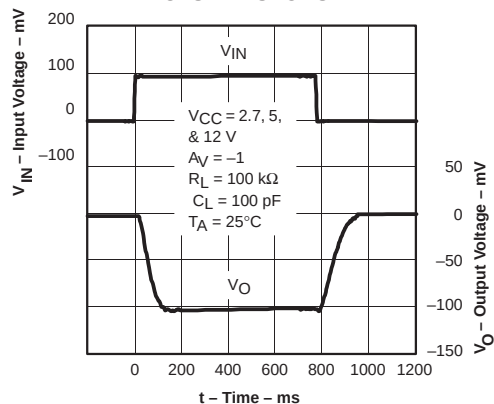


Figure 34

**CROSSTALK  
vs  
FREQUENCY**

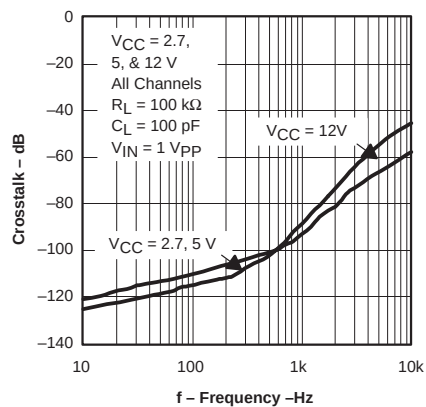
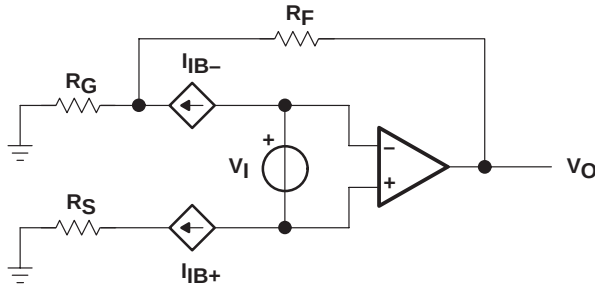


Figure 35

## APPLICATION INFORMATION

### offset voltage

The output offset voltage, ( $V_{OO}$ ) is the sum of the input offset voltage ( $V_{IO}$ ) and both input bias currents ( $I_{IB}$ ) times the corresponding gains. The following schematic and formula can be used to calculate the output offset voltage:

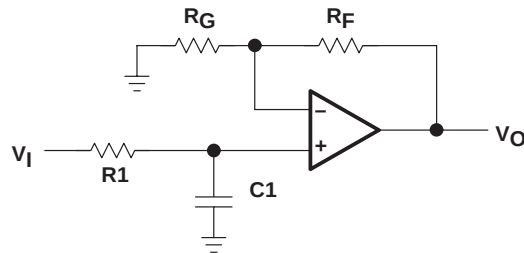


$$V_{OO} = V_{IO} \left( 1 + \left( \frac{R_F}{R_G} \right) \right) \pm I_{IB+} R_S \left( 1 + \left( \frac{R_F}{R_G} \right) \right) \pm I_{IB-} R_F$$

Figure 36. Output Offset Voltage Model

### general configurations

When receiving low-level signals, limiting the bandwidth of the incoming signals into the system is often required. The simplest way to accomplish this is to place an RC filter at the noninverting terminal of the amplifier (see Figure 37).

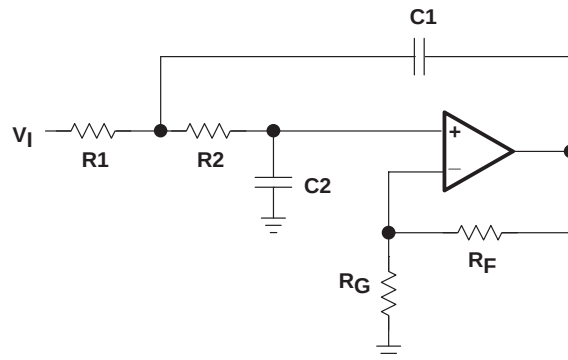


$$f_{-3dB} = \frac{1}{2\pi R_1 C_1}$$

$$\frac{V_O}{V_I} = \left( 1 + \frac{R_F}{R_G} \right) \left( \frac{1}{1 + sR_1 C_1} \right)$$

Figure 37. Single-Pole Low-Pass Filter

If even more attenuation is needed, a multiple pole filter is required. The Sallen-Key filter can be used for this task. For best results, the amplifier should have a bandwidth that is 8 to 10 times the filter frequency bandwidth. Failure to do this can result in phase shift of the amplifier.



$$\begin{aligned} R_1 &= R_2 = R \\ C_1 &= C_2 = C \\ Q &= \text{Peaking Factor} \\ &(\text{Butterworth } Q = 0.707) \end{aligned}$$

$$f_{-3dB} = \frac{1}{2\pi RC}$$

$$R_G = \frac{R_F}{\left( 2 - \frac{1}{Q} \right)}$$

Figure 38. 2-Pole Low-Pass Sallen-Key Filter

# TLV2241, TLV2242, TLV2244

## FAMILY OF 1- $\mu$ A/ch RAIL-TO-RAIL INPUT/OUTPUT

### OPERATIONAL AMPLIFIERS

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#### APPLICATION INFORMATION

##### circuit layout considerations

To achieve the levels of high performance of the TLV224x, follow proper printed-circuit board design techniques. A general set of guidelines is given in the following.

- Ground planes—It is highly recommended that a ground plane be used on the board to provide all components with a low inductive ground connection. However, in the areas of the amplifier inputs and output, the ground plane can be removed to minimize the stray capacitance.
- Proper power supply decoupling—Use a 6.8- $\mu$ F tantalum capacitor in parallel with a 0.1- $\mu$ F ceramic capacitor on each supply terminal. It may be possible to share the tantalum among several amplifiers depending on the application, but a 0.1- $\mu$ F ceramic capacitor should always be used on the supply terminal of every amplifier. In addition, the 0.1- $\mu$ F capacitor should be placed as close as possible to the supply terminal. As this distance increases, the inductance in the connecting trace makes the capacitor less effective. The designer should strive for distances of less than 0.1 inches between the device power terminals and the ceramic capacitors.
- Sockets—Sockets can be used but are not recommended. The additional lead inductance in the socket pins will often lead to stability problems. Surface-mount packages soldered directly to the printed-circuit board is the best implementation.
- Short trace runs/compact part placements—Optimum high performance is achieved when stray series inductance has been minimized. To realize this, the circuit layout should be made as compact as possible, thereby minimizing the length of all trace runs. Particular attention should be paid to the inverting input of the amplifier. Its length should be kept as short as possible. This will help to minimize stray capacitance at the input of the amplifier.
- Surface-mount passive components—Using surface-mount passive components is recommended for high performance amplifier circuits for several reasons. First, because of the extremely low lead inductance of surface-mount components, the problem with stray series inductance is greatly reduced. Second, the small size of surface-mount components naturally leads to a more compact layout thereby minimizing both stray inductance and capacitance. If leaded components are used, it is recommended that the lead lengths be kept as short as possible.



## APPLICATION INFORMATION

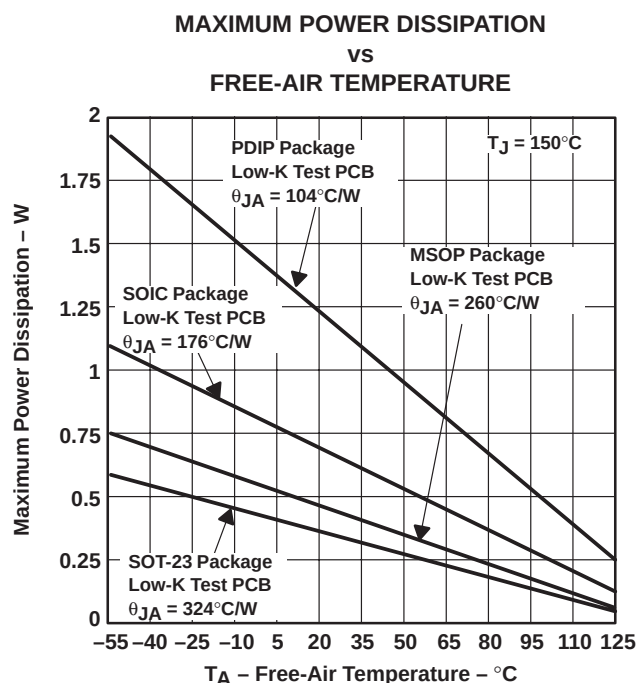
### general power dissipation considerations

For a given  $\theta_{JA}$ , the maximum power dissipation is shown in Figure 39 and is calculated by the following formula:

$$P_D = \left( \frac{T_{MAX} - T_A}{\theta_{JA}} \right)$$

Where:

- $P_D$  = Maximum power dissipation of THS224x IC (watts)
- $T_{MAX}$  = Absolute maximum junction temperature (150°C)
- $T_A$  = Free-ambient air temperature (°C)
- $\theta_{JA} = \theta_{JC} + \theta_{CA}$
- $\theta_{JC}$  = Thermal coefficient from junction to case
- $\theta_{CA}$  = Thermal coefficient from case to ambient air (°C/W)



NOTE A: Results are with no air flow and using JEDEC Standard Low-K test PCB.

**Figure 39. Maximum Power Dissipation vs Free-Air Temperature**

# TLV2241, TLV2242, TLV2244

## FAMILY OF 1- $\mu$ A/Ch RAIL-TO-RAIL INPUT/OUTPUT

### OPERATIONAL AMPLIFIERS

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## APPLICATION INFORMATION

### macromodel information

Macromodel information provided was derived using Microsim *Parts*™ Release 8, the model generation software used with Microsim *PSpice*™. The Boyle macromodel (see Note 2) and subcircuit in Figure 40 are generated using the TLV224x typical electrical and operating characteristics at  $T_A = 25^\circ\text{C}$ . Using this information, output simulations of the following key parameters can be generated to a tolerance of 20% (in most cases):

- Maximum positive output voltage swing
- Maximum negative output voltage swing
- Slew rate
- Quiescent power dissipation
- Input bias current
- Open-loop voltage amplification
- Unity-gain frequency
- Common-mode rejection ratio
- Phase margin
- DC output resistance
- AC output resistance
- Short-circuit output current limit

NOTE 2: G. R. Boyle, B. M. Cohn, D. O. Pederson, and J. E. Solomon, "Macromodeling of Integrated Circuit Operational Amplifiers", *IEEE Journal of Solid-State Circuits*, SC-9, 353 (1974).

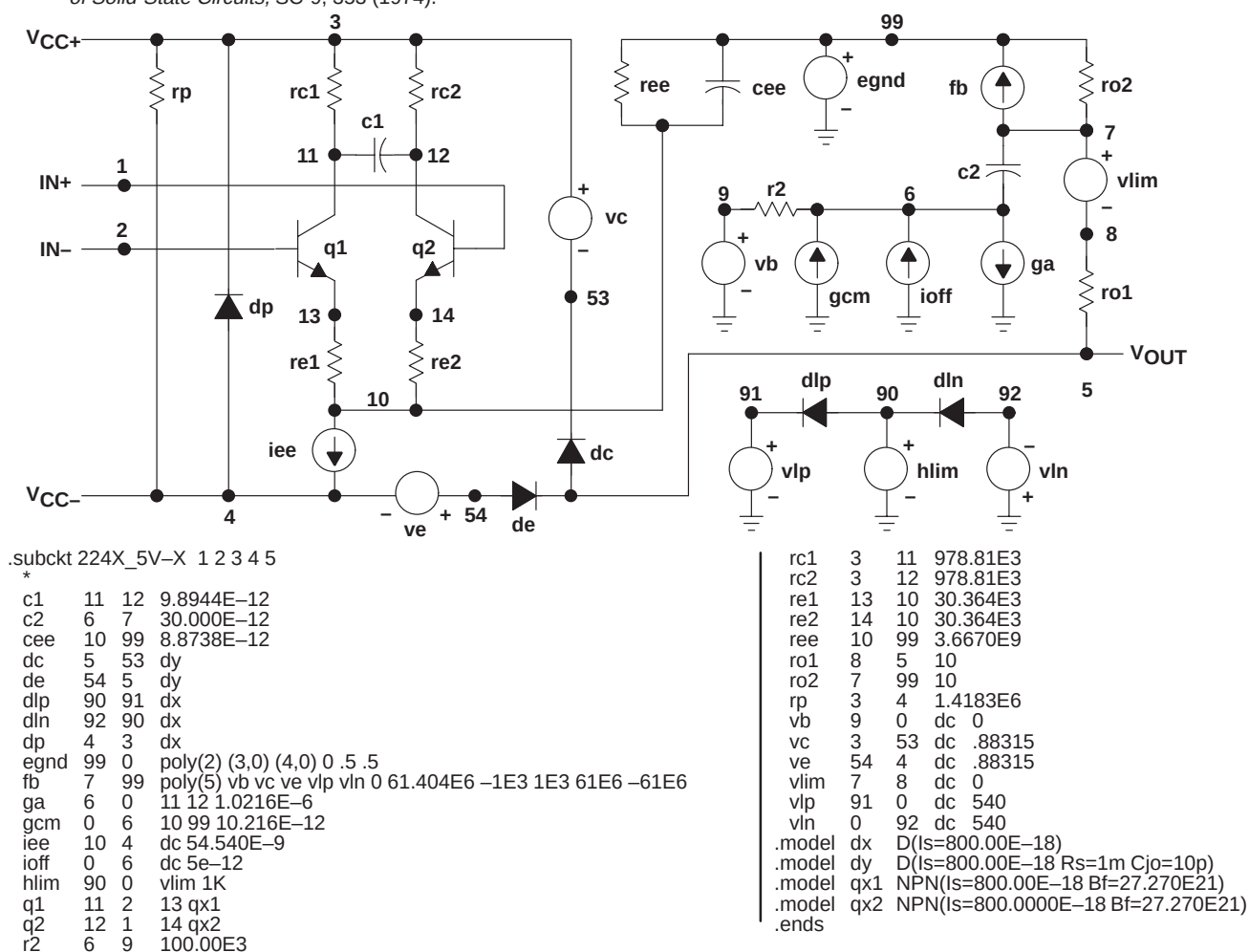


Figure 40. Boyle Macromodels and Subcircuit

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## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan<br>(2) | Lead finish/<br>Ball material<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| TLV2241ID        | ACTIVE        | SOIC         | D               | 8    | 75          | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 2241I                   | <a href="#">Samples</a> |
| TLV2241IDBVR     | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | VBEI                    | <a href="#">Samples</a> |
| TLV2241IDBVRG4   | ACTIVE        | SOT-23       | DBV             | 5    | 3000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | VBEI                    | <a href="#">Samples</a> |
| TLV2241IDBVT     | ACTIVE        | SOT-23       | DBV             | 5    | 250         | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | VBEI                    | <a href="#">Samples</a> |
| TLV2241IDR       | ACTIVE        | SOIC         | D               | 8    | 2500        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 2241I                   | <a href="#">Samples</a> |
| TLV2241IP        | ACTIVE        | PDIP         | P               | 8    | 50          | RoHS & Green    | NIPDAU                               | N / A for Pkg Type   | -40 to 125   | TLV2241I                | <a href="#">Samples</a> |
| TLV2242CD        | ACTIVE        | SOIC         | D               | 8    | 75          | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | 2242C                   | <a href="#">Samples</a> |
| TLV2242CDR       | ACTIVE        | SOIC         | D               | 8    | 2500        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | 0 to 70      | 2242C                   | <a href="#">Samples</a> |
| TLV2242ID        | ACTIVE        | SOIC         | D               | 8    | 75          | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 2242I                   | <a href="#">Samples</a> |
| TLV2242IDGK      | ACTIVE        | VSSOP        | DGK             | 8    | 80          | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | ALE                     | <a href="#">Samples</a> |
| TLV2242IDGKR     | ACTIVE        | VSSOP        | DGK             | 8    | 2500        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | ALE                     | <a href="#">Samples</a> |
| TLV2242IDGKRG4   | ACTIVE        | VSSOP        | DGK             | 8    | 2500        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | ALE                     | <a href="#">Samples</a> |
| TLV2242IDR       | ACTIVE        | SOIC         | D               | 8    | 2500        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 2242I                   | <a href="#">Samples</a> |
| TLV2242IP        | ACTIVE        | PDIP         | P               | 8    | 50          | RoHS & Green    | NIPDAU                               | N / A for Pkg Type   | -40 to 125   | TLV2242I                | <a href="#">Samples</a> |
| TLV2244ID        | ACTIVE        | SOIC         | D               | 14   | 50          | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | TLV2244I                | <a href="#">Samples</a> |
| TLV2244IDR       | ACTIVE        | SOIC         | D               | 14   | 2500        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | TLV2244I                | <a href="#">Samples</a> |
| TLV2244IN        | ACTIVE        | PDIP         | N               | 14   | 25          | RoHS & Green    | NIPDAU                               | N / A for Pkg Type   | -40 to 125   | TLV2244I                | <a href="#">Samples</a> |
| TLV2244IPW       | ACTIVE        | TSSOP        | PW              | 14   | 90          | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 2244I                   | <a href="#">Samples</a> |
| TLV2244IPWR      | ACTIVE        | TSSOP        | PW              | 14   | 2000        | RoHS & Green    | NIPDAU                               | Level-1-260C-UNLIM   | -40 to 125   | 2244I                   | <a href="#">Samples</a> |

<sup>(1)</sup> The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of  $\leq 1000$ ppm threshold. Antimony trioxide based flame retardants must also meet the  $\leq 1000$ ppm threshold requirement.

<sup>(3)</sup> MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

<sup>(4)</sup> There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

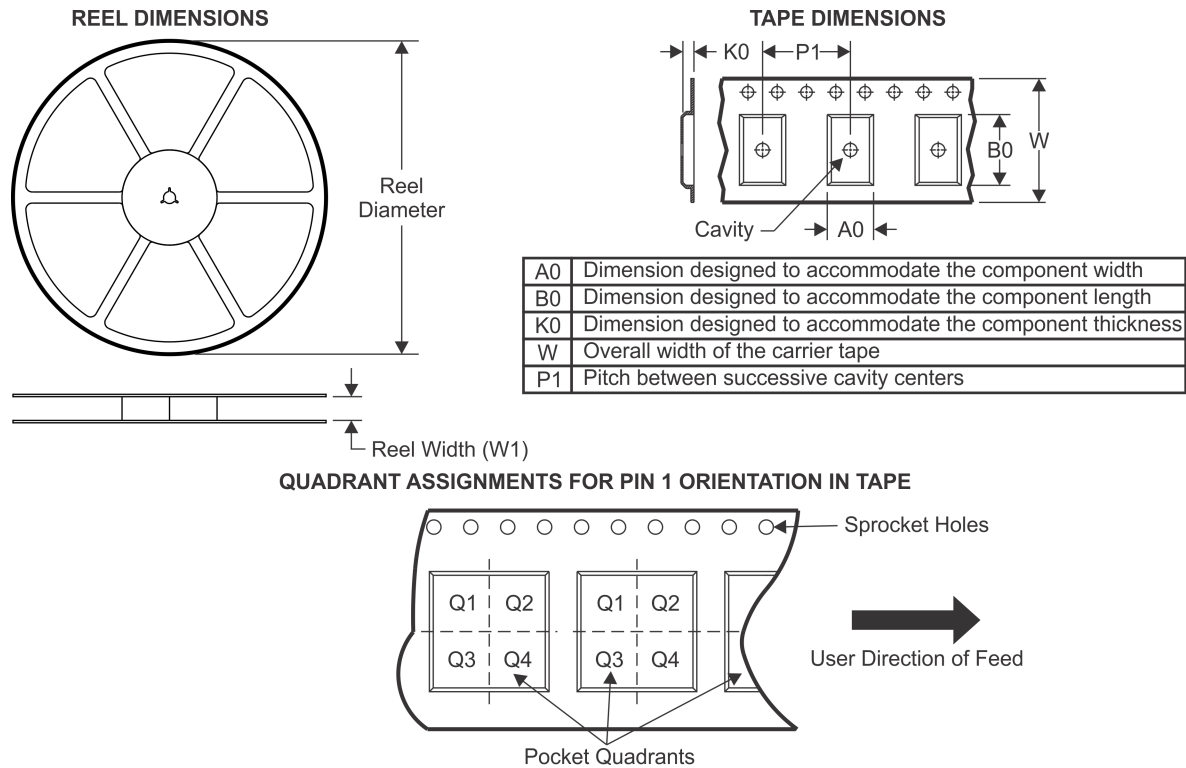
<sup>(5)</sup> Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

<sup>(6)</sup> Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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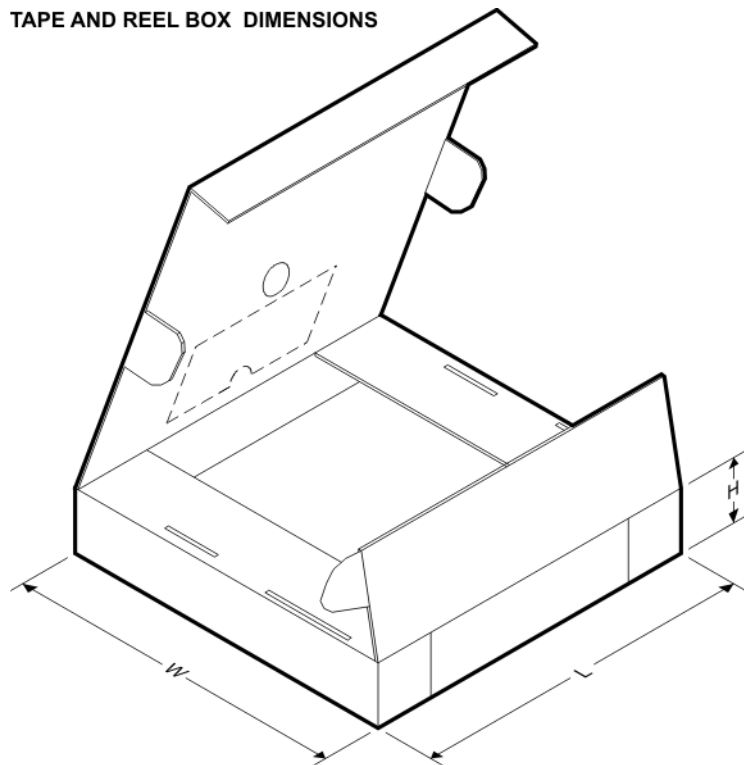
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TLV2241IDBVR | SOT-23       | DBV             | 5    | 3000 | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TLV2241IDBVT | SOT-23       | DBV             | 5    | 250  | 180.0              | 8.4                | 3.2     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TLV2241IDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TLV2242CDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TLV2242IDGKR | VSSOP        | DGK             | 8    | 2500 | 330.0              | 12.4               | 5.3     | 3.4     | 1.4     | 8.0     | 12.0   | Q1            |
| TLV2242IDR   | SOIC         | D               | 8    | 2500 | 330.0              | 12.4               | 6.4     | 5.2     | 2.1     | 8.0     | 12.0   | Q1            |
| TLV2244IDR   | SOIC         | D               | 14   | 2500 | 330.0              | 16.4               | 6.5     | 9.0     | 2.1     | 8.0     | 16.0   | Q1            |
| TLV2244IPWR  | TSSOP        | PW              | 14   | 2000 | 330.0              | 12.4               | 6.9     | 5.6     | 1.6     | 8.0     | 12.0   | Q1            |

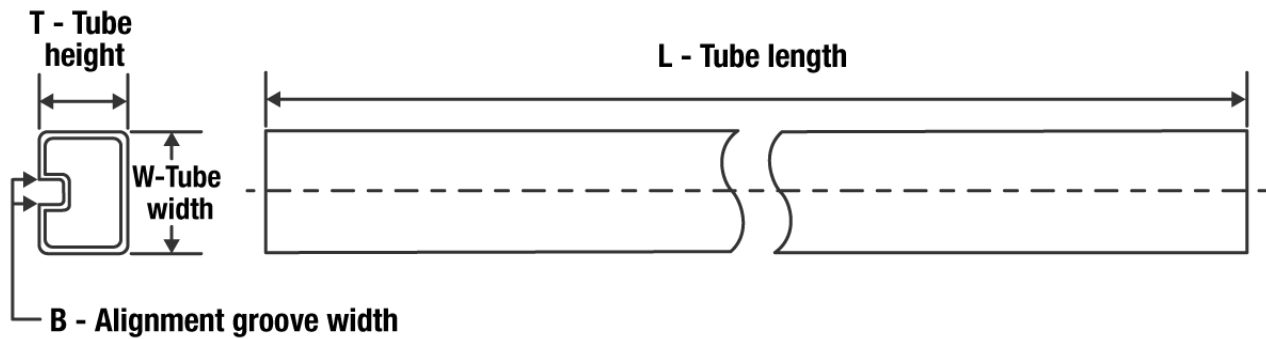
## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device       | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TLV2241IDBVR | SOT-23       | DBV             | 5    | 3000 | 210.0       | 185.0      | 35.0        |
| TLV2241IDBVT | SOT-23       | DBV             | 5    | 250  | 210.0       | 185.0      | 35.0        |
| TLV2241IDR   | SOIC         | D               | 8    | 2500 | 340.5       | 336.1      | 25.0        |
| TLV2242CDR   | SOIC         | D               | 8    | 2500 | 340.5       | 336.1      | 25.0        |
| TLV2242IDGKR | VSSOP        | DGK             | 8    | 2500 | 358.0       | 335.0      | 35.0        |
| TLV2242IDR   | SOIC         | D               | 8    | 2500 | 340.5       | 336.1      | 25.0        |
| TLV2244IDR   | SOIC         | D               | 14   | 2500 | 350.0       | 350.0      | 43.0        |
| TLV2244IPWR  | TSSOP        | PW              | 14   | 2000 | 853.0       | 449.0      | 35.0        |

## TUBE



\*All dimensions are nominal

| Device     | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| TLV2241ID  | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLV2241ID  | D            | SOIC         | 8    | 75  | 505.46 | 6.76   | 3810   | 4      |
| TLV2241IP  | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLV2242CD  | D            | SOIC         | 8    | 75  | 505.46 | 6.76   | 3810   | 4      |
| TLV2242CD  | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLV2242ID  | D            | SOIC         | 8    | 75  | 507    | 8      | 3940   | 4.32   |
| TLV2242ID  | D            | SOIC         | 8    | 75  | 505.46 | 6.76   | 3810   | 4      |
| TLV2242IP  | P            | PDIP         | 8    | 50  | 506    | 13.97  | 11230  | 4.32   |
| TLV2244ID  | D            | SOIC         | 14   | 50  | 505.46 | 6.76   | 3810   | 4      |
| TLV2244IN  | N            | PDIP         | 14   | 25  | 506    | 13.97  | 11230  | 4.32   |
| TLV2244IPW | PW           | TSSOP        | 14   | 90  | 530    | 10.2   | 3600   | 3.5    |

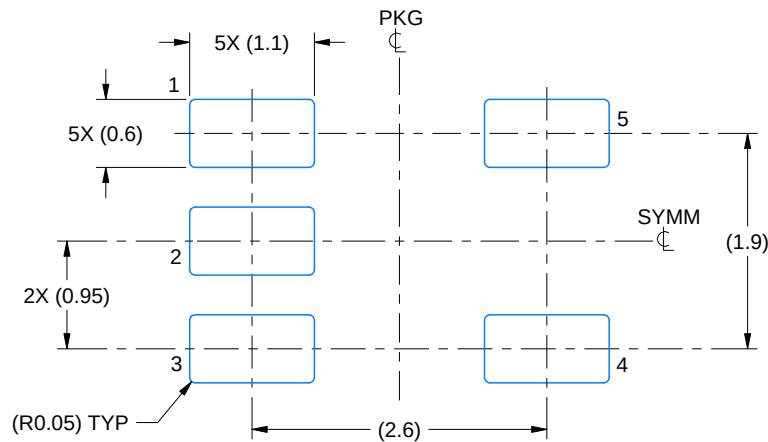


# EXAMPLE BOARD LAYOUT

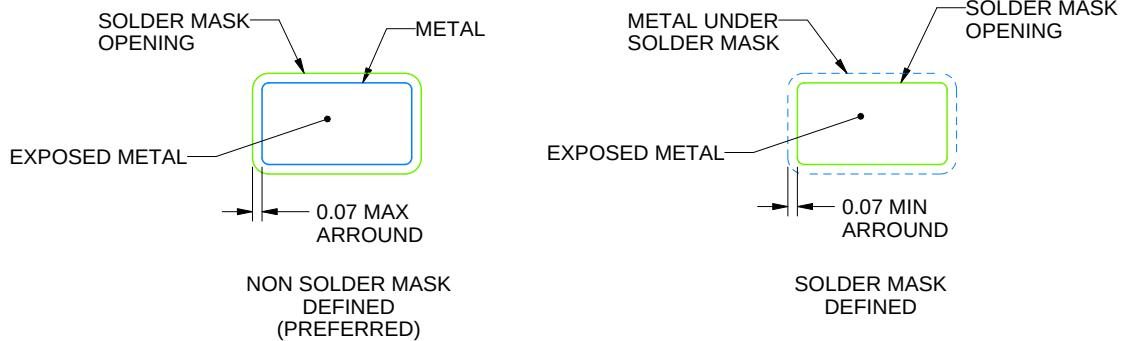
DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



SOLDER MASK DETAILS

4214839/F 06/2021

NOTES: (continued)

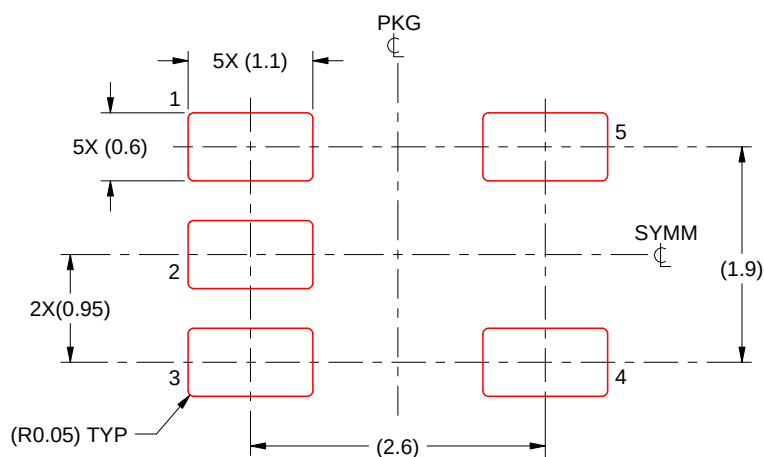
5. Publication IPC-7351 may have alternate designs.
6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

DBV0005A

SOT-23 - 1.45 mm max height

SMALL OUTLINE TRANSISTOR



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:15X

4214839/F 06/2021

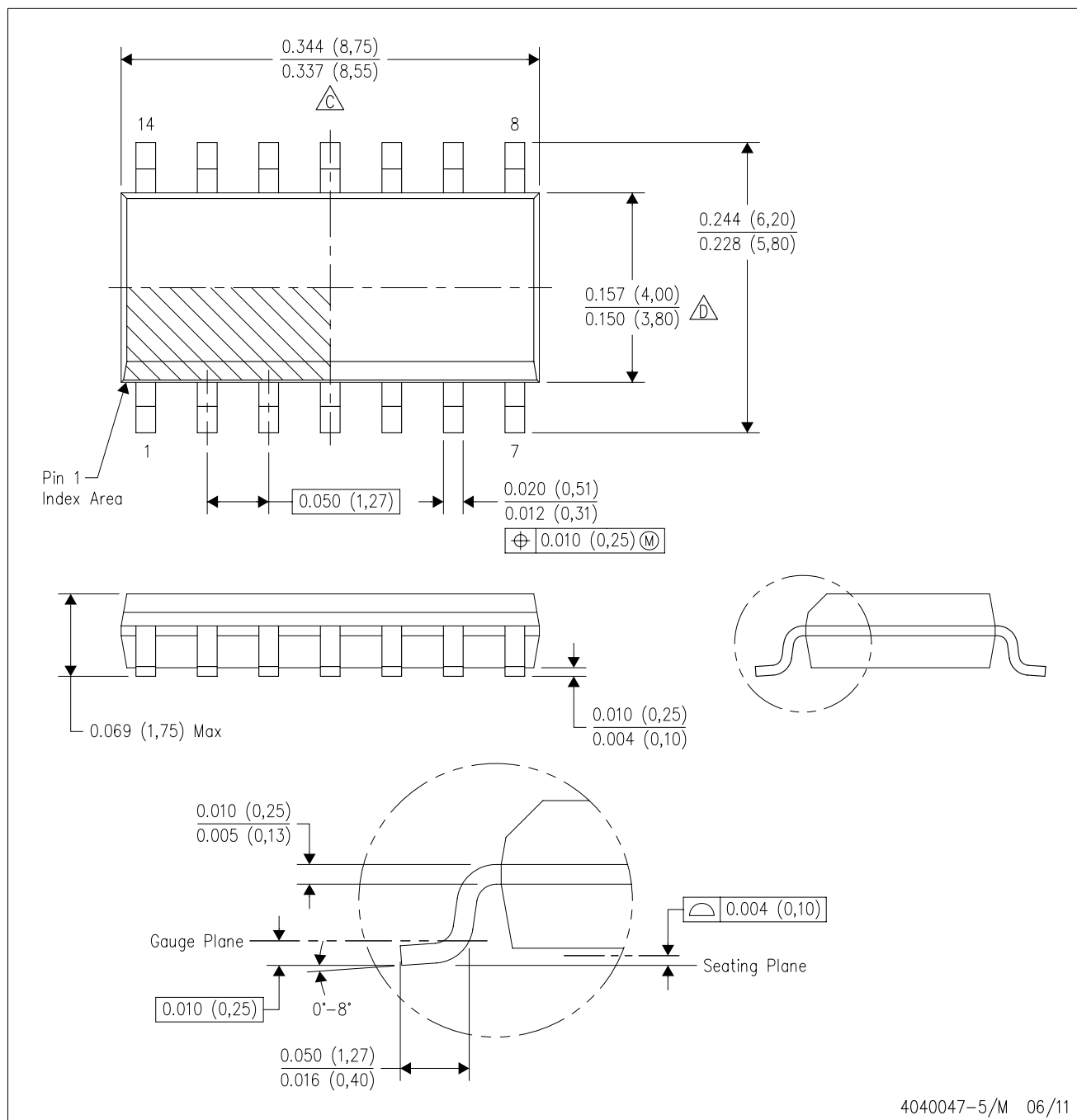
NOTES: (continued)

7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
8. Board assembly site may have different recommendations for stencil design.



D (R-PDSO-G14)

PLASTIC SMALL OUTLINE

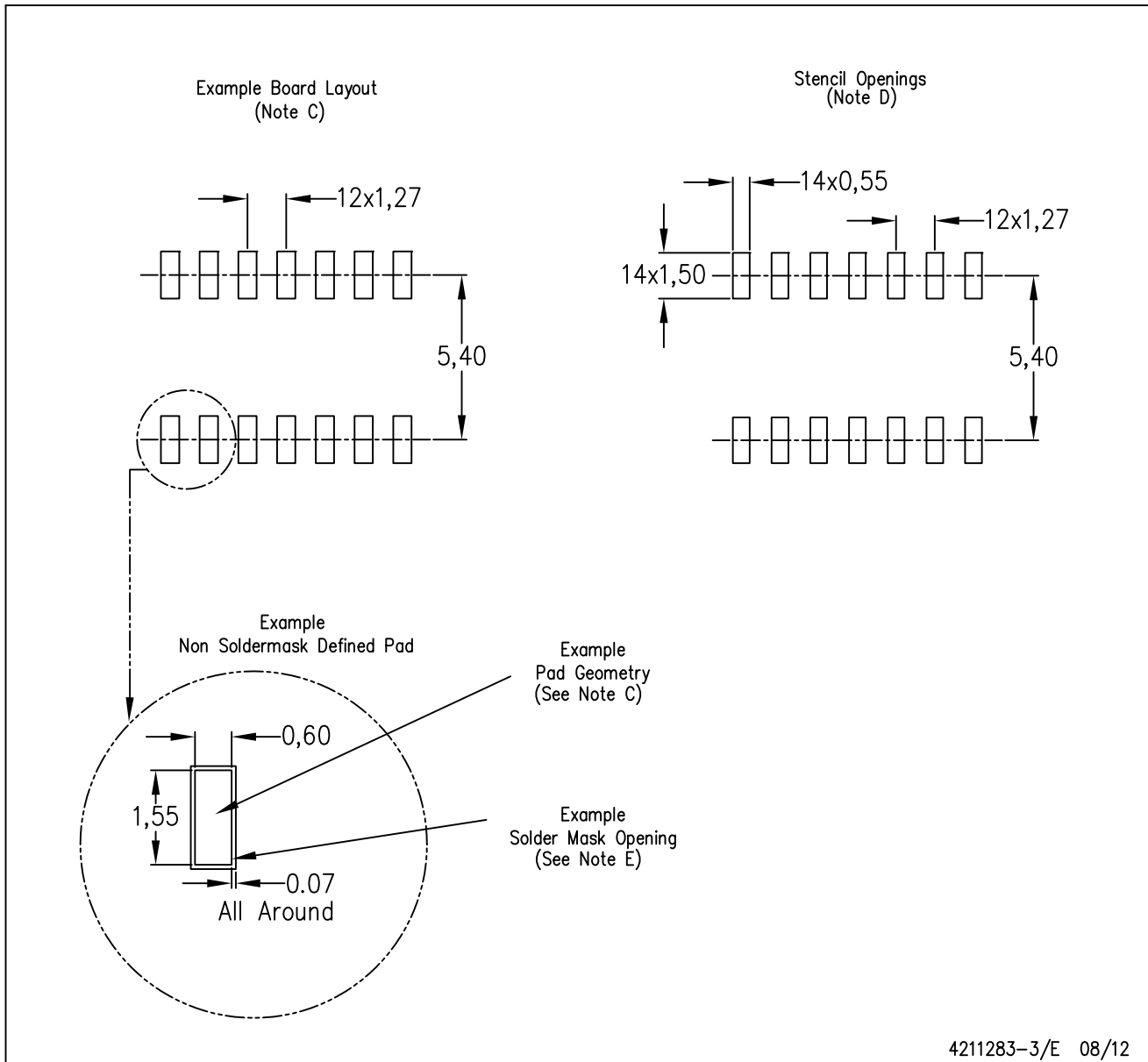


NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- D. Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.

D (R-PDSO-G14)

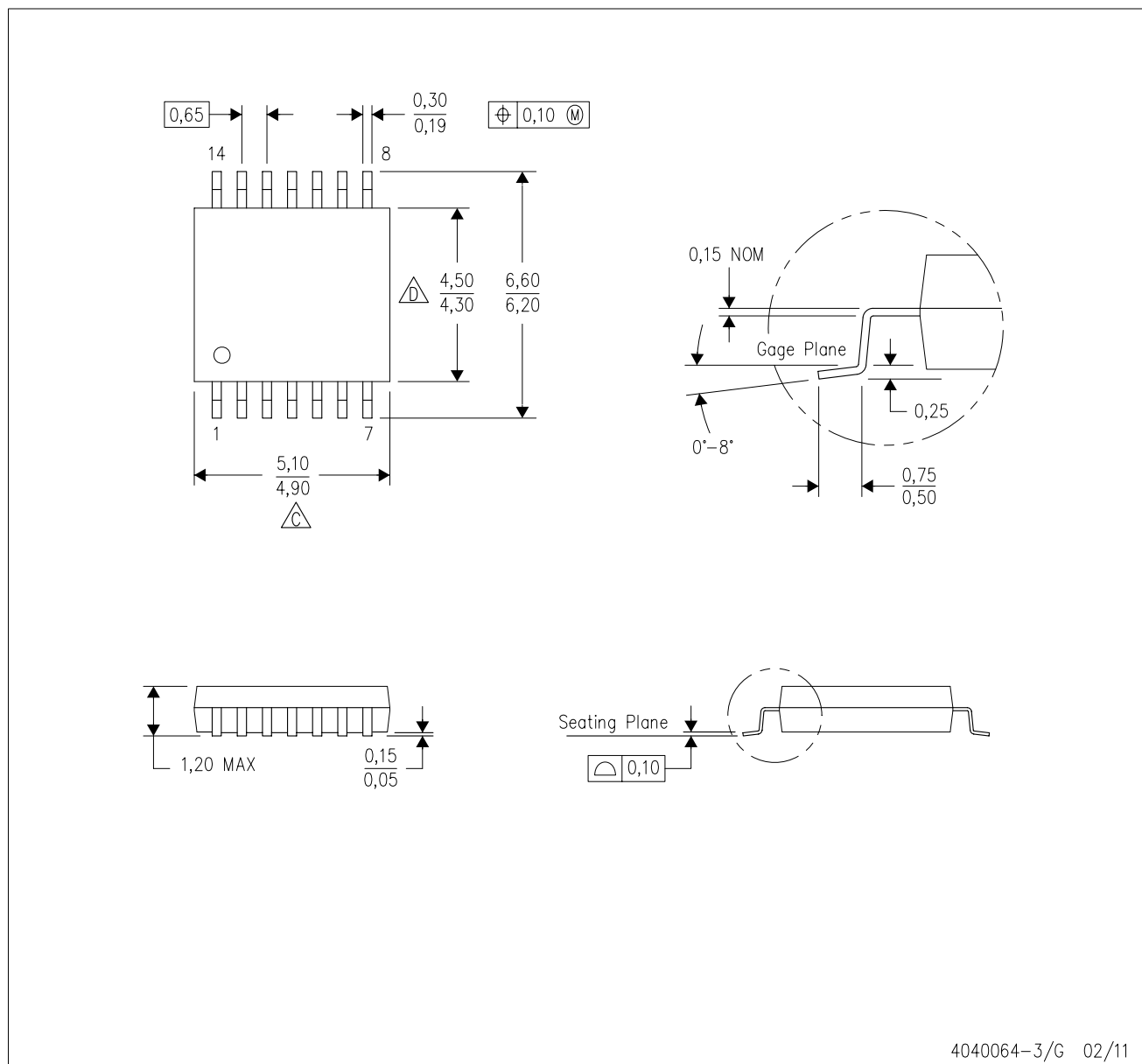
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE

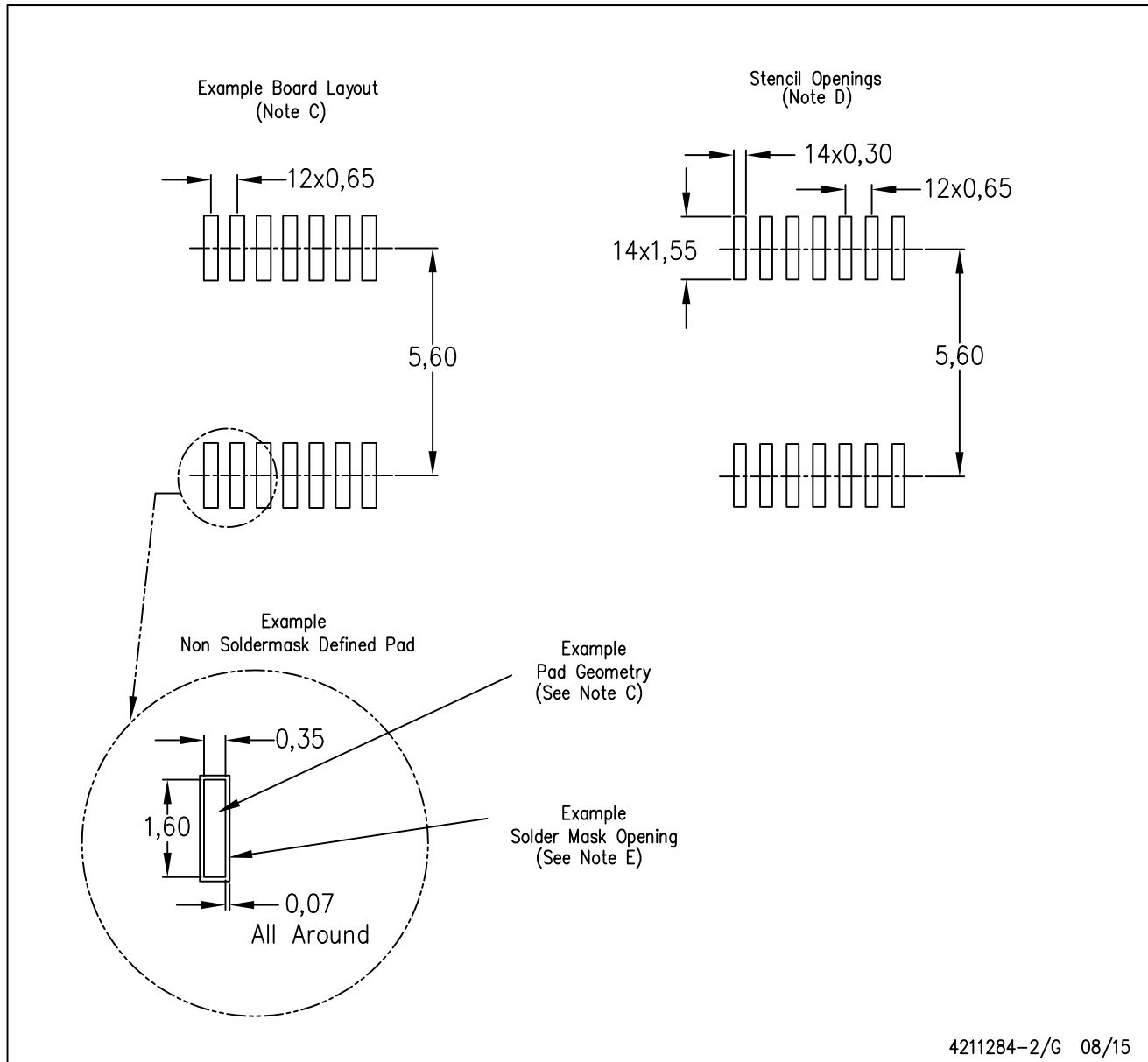


4040064-3/G 02/11

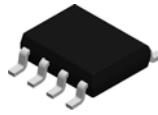
- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.
  - D. Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.
  - E. Falls within JEDEC MO-153

PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

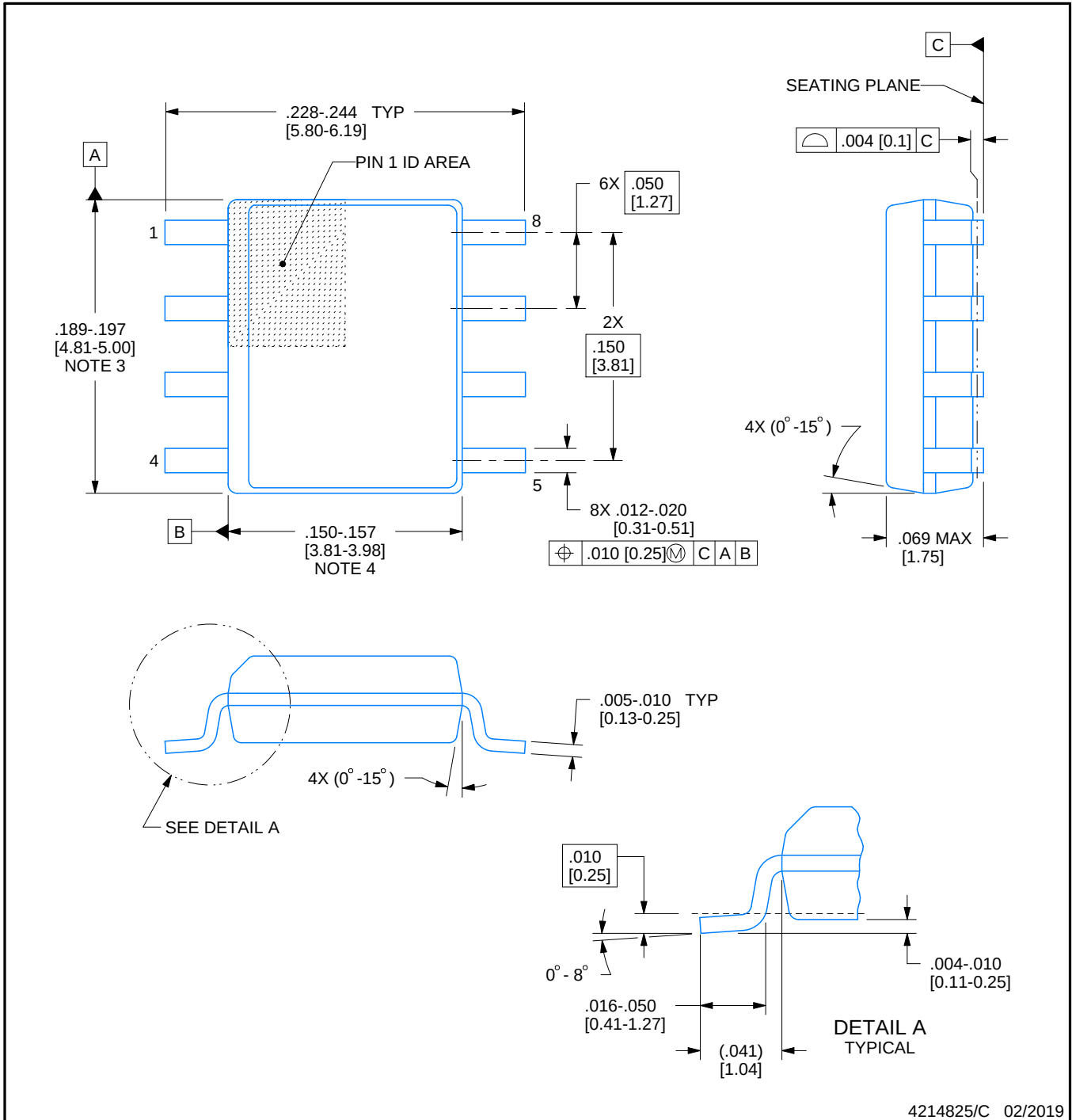


**D0008A**

# PACKAGE OUTLINE

**SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

## NOTES:

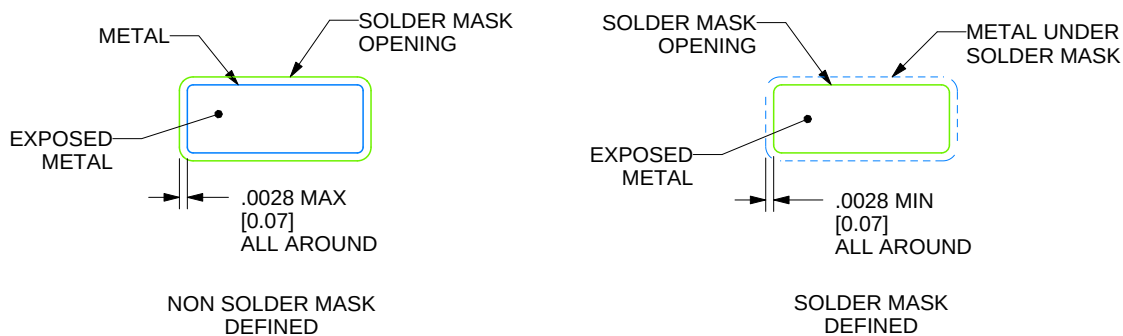
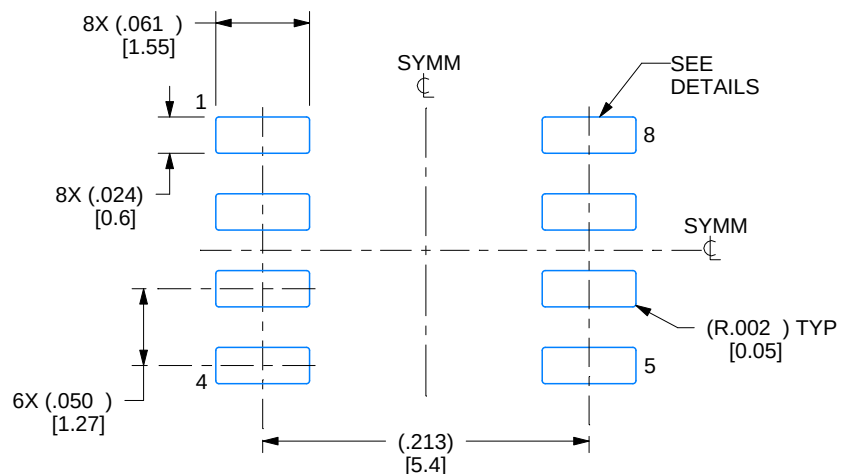
1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

# EXAMPLE BOARD LAYOUT

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

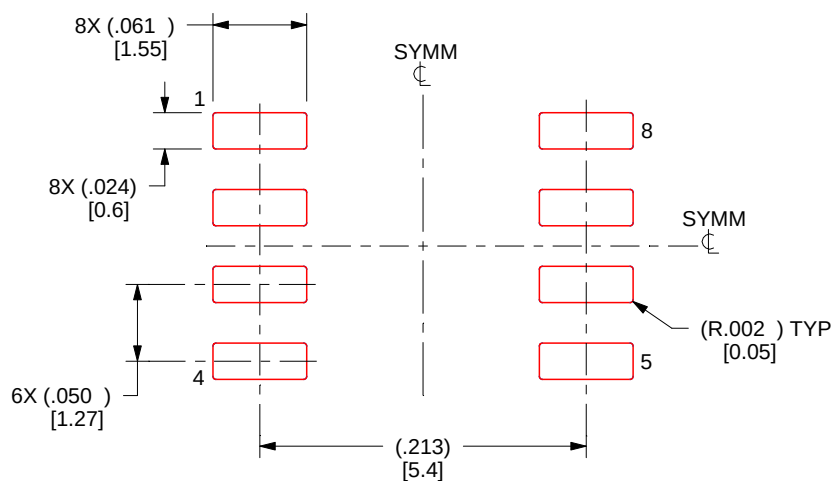
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON .005 INCH [0.125 MM] THICK STENCIL  
SCALE:8X

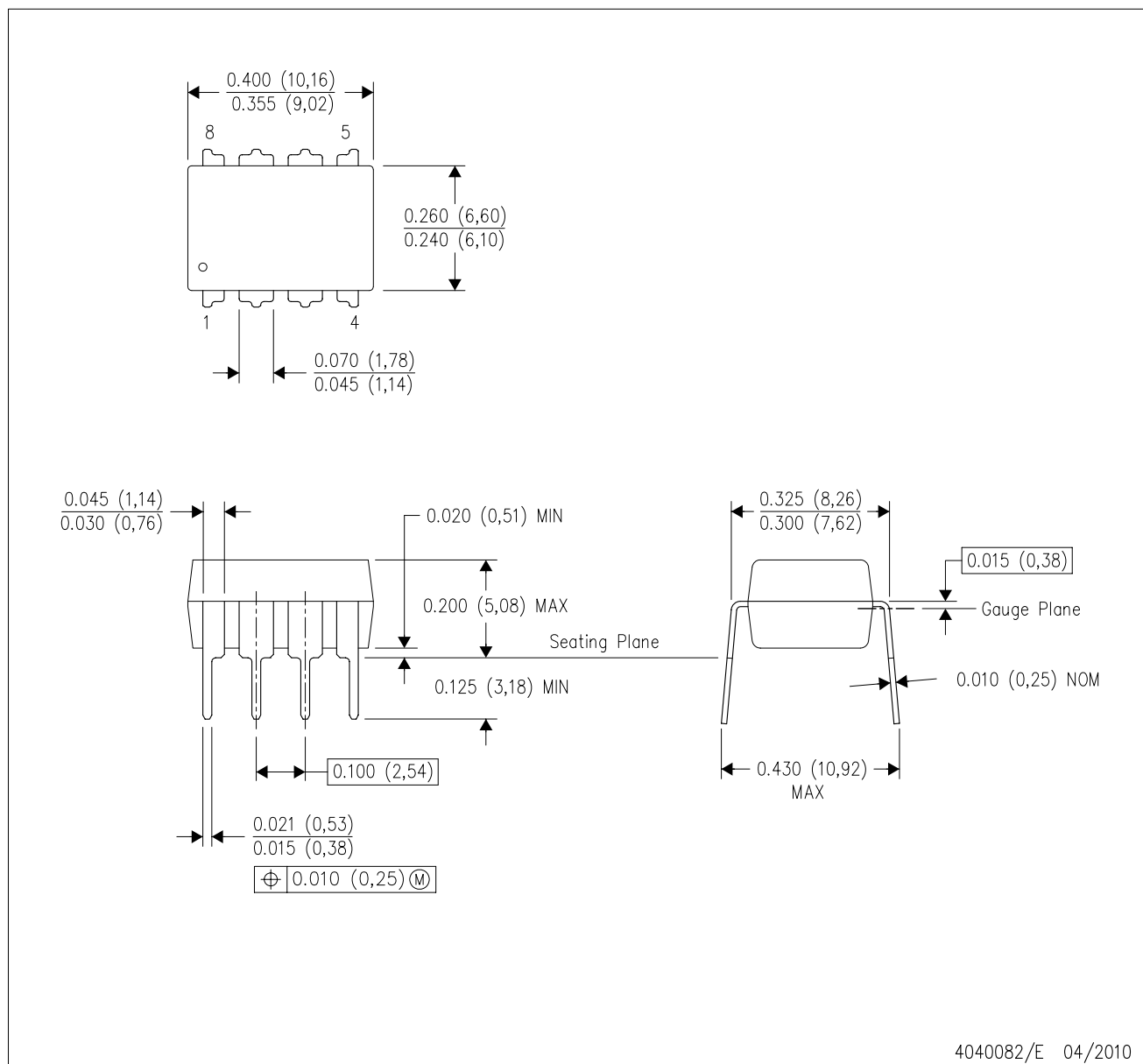
4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



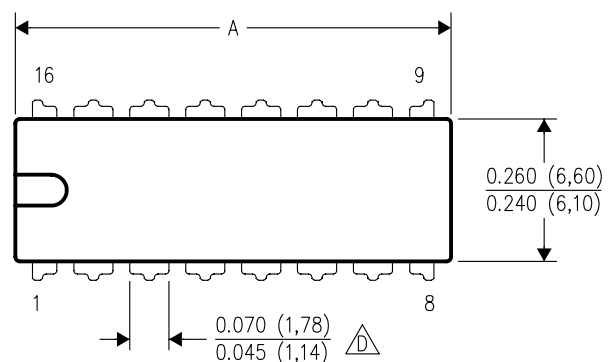
- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001 variation BA.



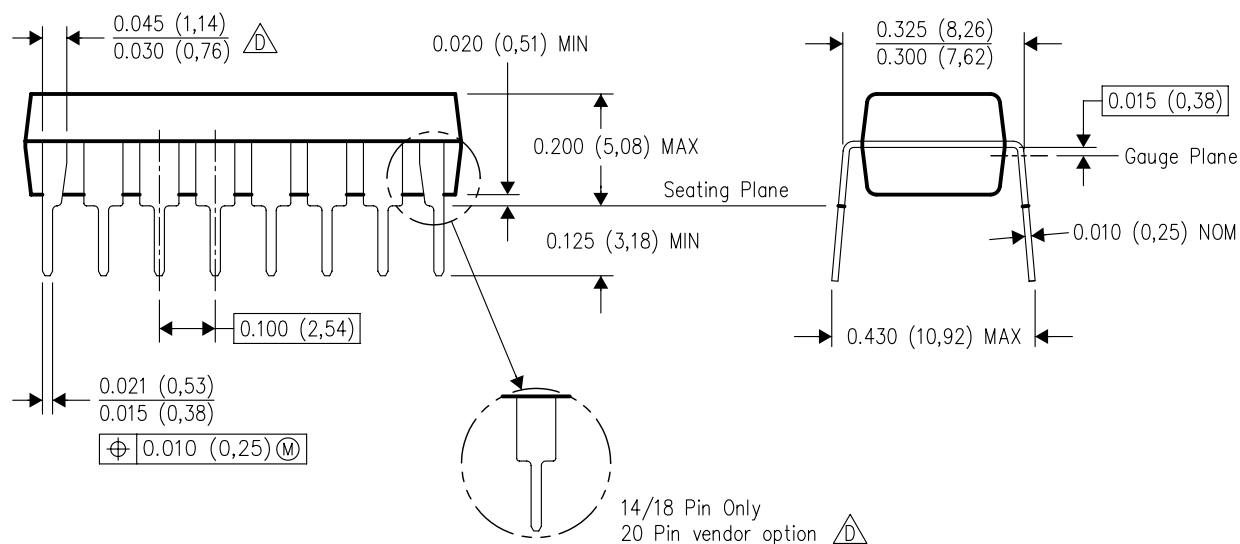
## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **             | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| DIM                 |                  |                  |                  |                  |
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |

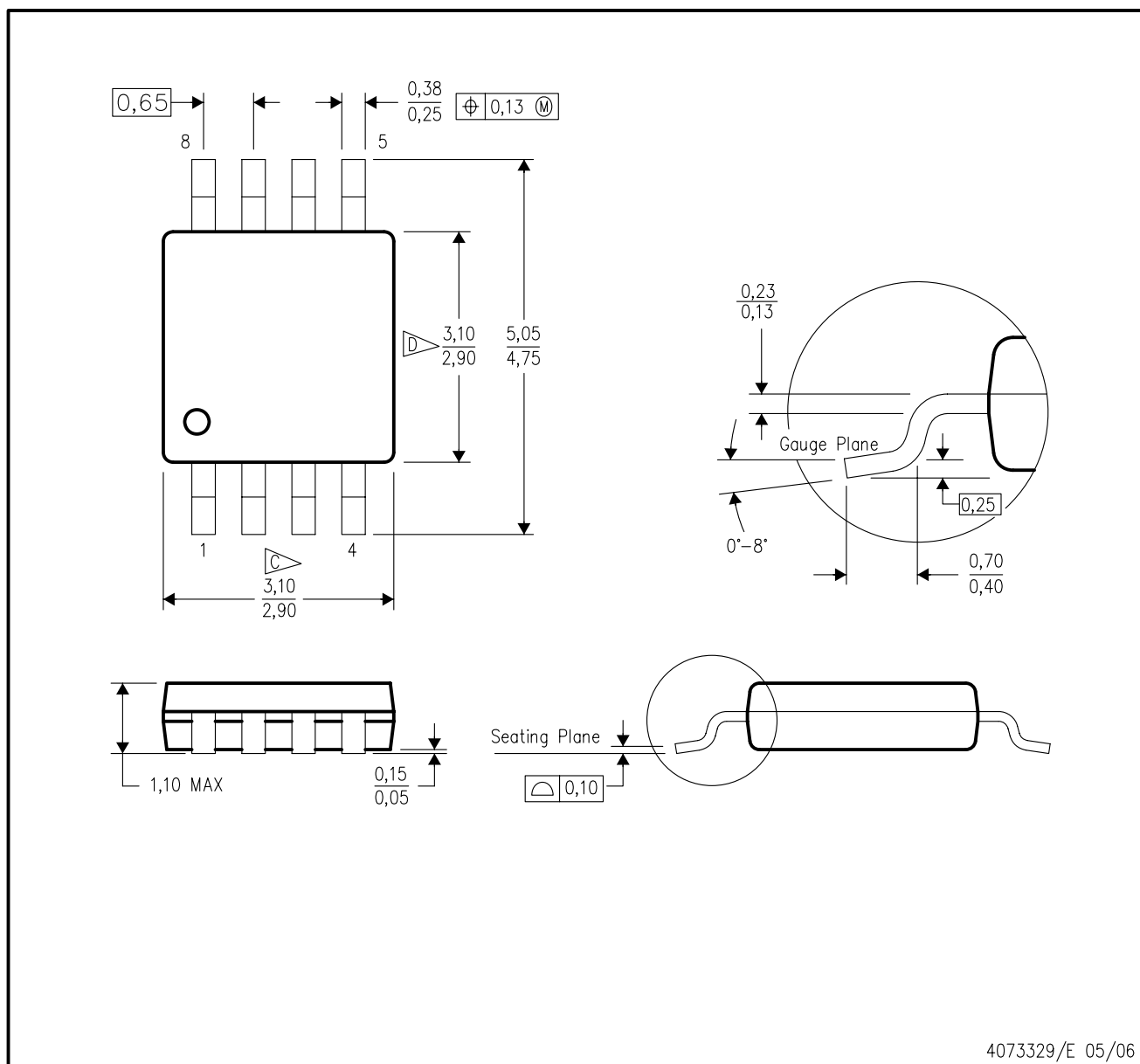


4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

DGK (S-PDSO-G8)

PLASTIC SMALL-OUTLINE PACKAGE

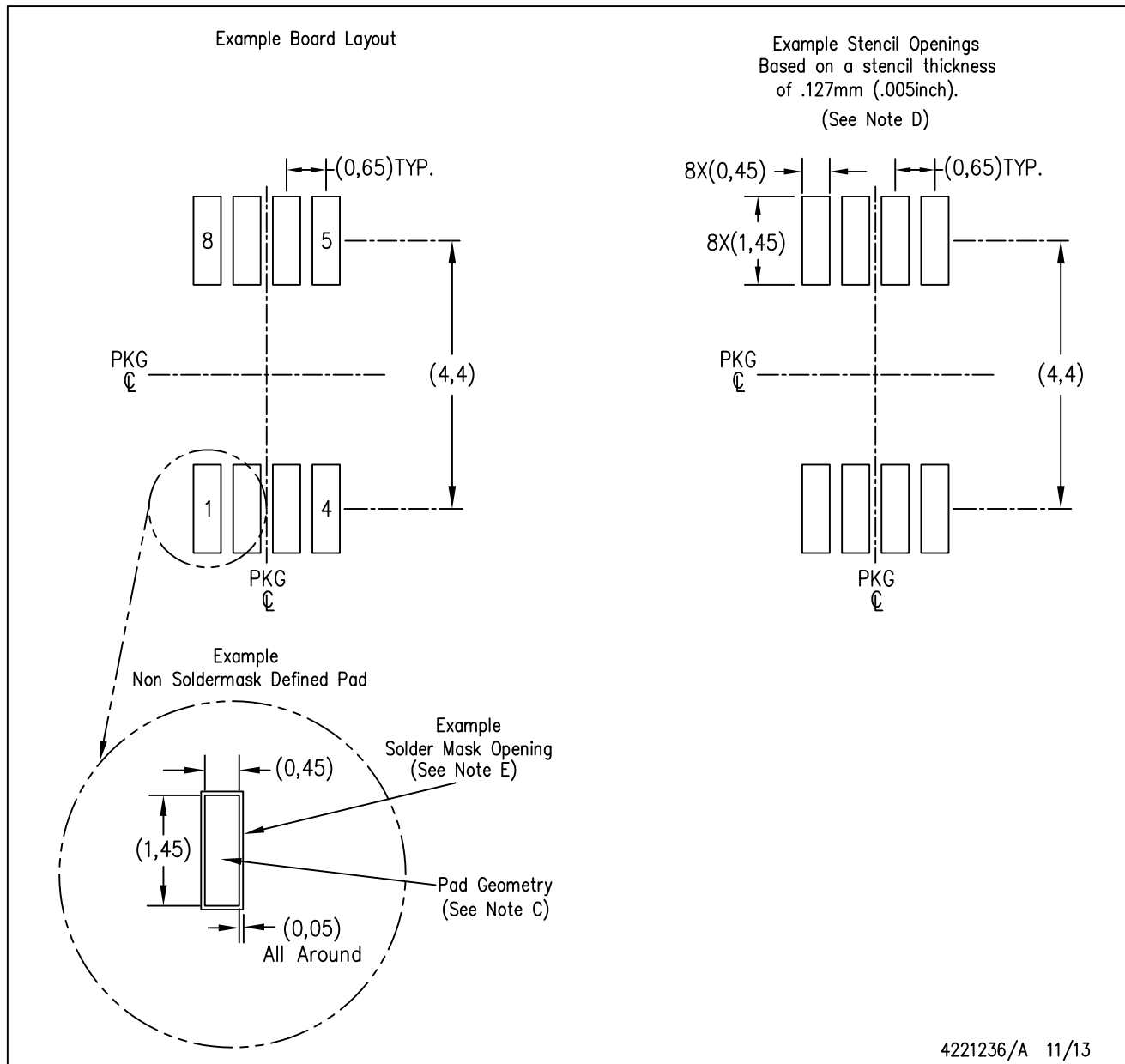


## NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 per end.
- D. Body width does not include interlead flash. Interlead flash shall not exceed 0.50 per side.
- E. Falls within JEDEC MO-187 variation AA, except interlead flash.

DGK (S-PDSO-G8)

PLASTIC SMALL OUTLINE PACKAGE



- NOTES:
- All linear dimensions are in millimeters.
  - This drawing is subject to change without notice.
  - Publication IPC-7351 is recommended for alternate designs.
  - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
  - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

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